

Accelerometer Series

Accelerometer IC

KX022ACR-Z

General Description

KX022ACR-Z is a tri-axis ±2 g, ±4 g, ±8 g or ±16 g silicon micromachined accelerometer. Acceleration sensing is based on the principle of a differential capacitance arising from acceleration-induced motion of the sense element which further utilize common mode cancellation to decrease errors from process variation, temperature, and environmental stress.

Features

- User-selectable Acceleration Range and Output Data Rate
- User-selectable Low Power or High Resolution Mode
- Digital High-pass Filter Outputs
- Embedded FIFO/FILO Buffer
- Configurable Low Power Mode
- Enhanced integrated Free Fall, Directional Single-tap/ Double-tap, and Device-orientation Algorithms
- User-configurable Wake-up / Back-to-sleep Function
- Digital I²C up to 400 kHz
- Digital SPI up to 10 MHz
- Lead-free Solderability
- Excellent Temperature Performance
- High Shock Survivability
- Factory Programmed Offset and Sensitivity
- Self-test Function

Applications

- Mobile, Wearable, Hearable
- Healthcare, Fitness
- PC, Tablet, Game, Smart Audio
- Home Appliance, Office Equipment

Key Specifications

■ Acceleration Range: ±2 g, ±4 g, ±8 g or ±16 g

■ Wake-up and Back-to-sleep Engine

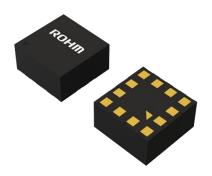
Threshold Resolution: 3.9 mg/counts
■ Output Data Rate: 0.781 Hz to 1600 Hz

■ Embedded Buffer: 43 or 86 Stored Samples

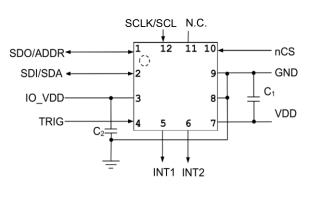
■ Operating Temperature Range: -40 °C to +85 °C

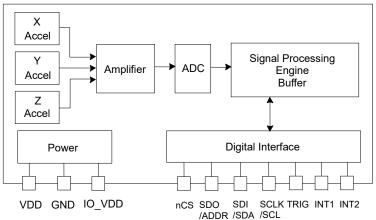
Package VLGA012AV02A

W (Typ) x **D (Typ)** x **H (Max)** 2.0 mm x 2.0 mm x 1.0 mm



Typical Application Circuit and Block Diagram



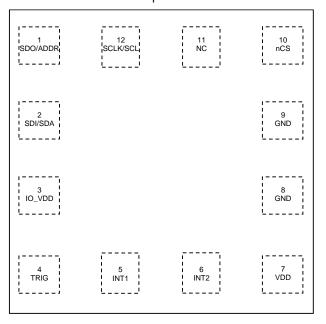


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Pin Configuration





Pin Description

| Pin No. | Pin Name | Function |
|---------|----------|--|
| 1 | SDO/ADDR | Serial Data Out pin during 4-wire SPI communication and part of the device address during I ² C communication. Do not leave floating. |
| 2 | SDI/SDA | SPI Data input / I ² C Serial Data pin ^(Note 1) . Do not leave floating. |
| 3 | IO_VDD | Power voltage pin ^(Note 2) . |
| 4 | TRIG | Trigger pin for FIFO buffer control. Connect to GND when not using external trigger option. |
| 5 | INT1 | Physical Interrupt (Push-Pull). The pin is in High-Z state during POR and is driven LOW following POR. Leave floating if not used. |
| 6 | INT2 | Physical Interrupt (Push-Pull). The pin is in High-Z state during POR and is driven LOW following POR. Leave floating if not used. |
| 7 | VDD | Power voltage pin ^(Note 2) . |
| 8 | GND | Ground |
| 9 | GND | Ground |
| 10 | nCS | Chip Select (active LOW) for SPI communication. Connect to IO_VDD for I ² C communication. Do not leave floating. |
| 11 | N.C. | Not internally connected. Can be connected to VDD, IO_VDD, GND or leave floating. |
| 12 | SCLK/SCL | SPI and I ² C Serial Clock pin ^(Note 1) . Do not leave floating. |

(Note 1) When there is other device which is connected to SDA, SCL or INT pins and its signal falls sharply, that might generate undershoot and the pin voltage might go below ground. When such undershoot occurs, a measure like disposing a capacitor near the pins of the device must be taken. (Note 2) Place a bypass capacitor (0.1 μ F) as close as possible to the IC.

Absolute Maximum Ratings(Ta = 25 °C)

| Parameter | Symbol | Rating | Unit |
|--|------------------|---|------|
| Supply Voltage (VDD, IO_VDD) | V _{MAX} | 4.5 | V |
| Input/Output Voltage ^(Note 1) | VINOUT | -0.3 to +4.5 | V |
| Storage Temperature Range | Tstg | -40 to +125 | °C |
| Maximum Junction Temperature | Tjmax | 150 | °C |
| Mech. Shock (Powered and Unpowered) | Sovr | 5000 g for 0.5 ms 10000 g for 0.2 ms | g |

(Note 1) SDO/ADDR, SDI/SDA, TRIG, INT1, INT2, nCS, and SCLK/SCL pins

Caution 1: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Caution 2: Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, design a PCB with thermal resistance taken into consideration by increasing board size and copper area so as not to exceed the maximum junction temperature rating.

Thermal Resistance(Note 2)

| | | Thormal Doo | viotopoo (Typ) | | |
|--|-------------|------------------------|--------------------------|------|--|
| Parameter | Symbol | Theimai Res | Thermal Resistance (Typ) | | |
| i didiliotoi | Cymbol | 1s ^(Note 4) | 2s2p ^(Note 5) | Unit | |
| VLGA012AV02A | | | | | |
| Junction to Ambient | θја | 195.7 | 131.0 | °C/W | |
| Junction to Top Characterization Parameter ^(Note 3) | Ψ_{JT} | 8 | 6 | °C/W | |

(Note 2) Based on JESD51-2A(Still-Air)

(Note 3) The thermal characterization parameter to report the difference between junction temperature and the temperature at the top center of the outside surface of the component package.

| (Note 4) Using | a PCB | board | based | on | JESD51-3. |
|----------------|-------|-------|-------|----|-----------|
| (Note 5) Using | a PCB | board | based | on | JFSD51-7 |

| (Note 5) Using a PCB board based | | | | | |
|--------------------------------------|------------------|-------------------------------|-------------------------------|--------------------------|--|
| Layer Number of Measurement Board | Material | Board Size | | | |
| Single | FR-4 | 114.3 mm x 76.2 mm x | 114.3 mm x 76.2 mm x 1.57 mmt | | |
| Тор | | | | | |
| Copper Pattern | Thickness | | | | |
| Footprints and Traces | 70 µm | | | | |
| Layer Number of | | Board Size | | | |
| Measurement Board | Material | Board Size | | | |
| _ | Material FR-4 | Board Size 114.3 mm x 76.2 mm | x 1.6 mmt | | |
| Measurement Board | | | | Bottom | |
| Measurement Board 4 Layers | | 114.3 mm x 76.2 mm | | Bottom Copper Pattern | |

Recommended Operating Conditions

| Parameter | Symbol | Min | Тур | Max | Unit |
|---|----------------------|-------|----------------|-----------|------|
| Supply Voltage (VDD) | V _{VDD} | 1.7 | 2.5 | 3.6 | V |
| I/O Pads Supply Voltage (IO_VDD) | V _{IO_VDD} | 1.7 | 2.5 | V_{VDD} | V |
| Input Voltage | Vin | 0.0 | - | 3.6 | V |
| I ² C Communication Rate | f _{SCL_i2C} | - | - | 0.4 | MHz |
| SPI Communication Rate | fscl_spi | - | - | 10 | MHz |
| I ² C Target Address ^(Note 6) | - | | 1Eh or 1Fh | 1 | - |
| WHO_AM_I register value | - | | C8h | | - |
| Output Data Rate ^(Note 7) | - | 0.781 | 50 | 1600 | Hz |
| Output Signal Bandwidth ^(Note 8) | - | OD | ODR/9 or ODR/2 | | - |
| Operating Temperature | Topr | -40 | +25 | +85 | °C |

(Note 6) Determined by ADDR pin assignment: GND for 1Eh, IO_VDD for 1Fh.

(Note 7) Typical values. ODR is user-selectable via I2C or SPI. See ODCNTL register for details.

(Note 8) Refers to accelerometer's raw output data.

Thickness 70 µm

Electrical Characteristics

| (Unless ot | herwise spe | cified V _{VDD} | = 2.5 V, V _{IC} | $_{VDD} = 2.5$ | V, Ta = 25 ° | C, Acceleration Range = ±2 |
|---|--------------------|-----------------------------|--------------------------|-----------------------------|--------------|----------------------------|
| Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
| Current Consumption | | | | 1 | 1 | |
| Operating(High Resolution Mode) ODR = 400 Hz | I _{dd_HR} | - | 220 | - | μA | |
| Operating(Low Power Mode) ODR = 50 Hz ^(Note 1) | I _{dd_LP} | - | 10 | - | μA | |
| Standby Mode | Iss | - | 0.9 | - | μA | |
| Logic | | | | | | |
| L Input Voltage | VIL | - | - | 0.2x V _{IO_VDD} | V | |
| H Input Voltage | V _{IH} | 0.8x V _{IO_VDD} | - | - | V | |
| L Output Voltage1 ^(Note 2) | V _{OL1} | - | - | 0.2x V _{IO_VDD} | V | IO_VDD < 2 V |
| L Output Voltage2 ^(Note 2) | V _{OL2} | - | - | 0.4 | V | IO_VDD ≥ 2 V |
| H Output Voltage | Vон | 0.8x V _{IO_VDD} | - | - | V | |
| Boot characteristics | | | | | | |
| Start Up Time ^(Note 3) | T_{SU} | 1 | - | 1300 | ms | |
| Power Up Time ^(Note 4) | T _{PU} | - | 20 | 50 | ms | |
| Accelerometer characteristics | | | | | | |
| Zero-g Offset | - | - | ±25 | ±90 | mg | |
| Zero-g Offset Variation from RT over Temperature | - | - | ±0.2 | - | mg/°C | |
| Sensitivity1 ^(Note 5) | - | 15401 | 16384 | 17367 | counts/g | GSEL [1:0] = 0 (±2 g) |
| Sensitivity2 ^(Note 5) | - | 7700 | 8192 | 8684 | counts/g | GSEL [1:0] = 1 (±4 g) |
| Sensitivity3 ^(Note 5) | - | 3850 | 4096 | 4342 | counts/g | GSEL [1:0] = 2 (±8 g) |
| Sensitivity4 ^(Note 5) | - | 1925 | 2048 | 2171 | counts/g | GSEL [1:0] = 3 (±16 g) |
| Sensitivity Variation from RT | - | - | ±0.01 | - | %/°C | X,Y-axis |
| over Temperature | - | - | ±0.03 | - | %/°C | Z-axis |
| Positive Self-test Output Change on Activation | - | - | 0.5 | - | g | |
| Mechanical Signal Bandwidth | - | - | 3.5 | - | kHz | X,Y-axis |
| (-3dB) (Note 6) | - | - | 1.8 | - | kHz | Z-axis |
| Non-Linearity | - | - | ±0.6 | - | % of FS | |
| Cross Axis Sensitivity | - | - | 2 | - | % | |
| RMS Noise ^(Note 7) | - | - | 0.7 | - | mg | High Resolution Mode |

⁽Note 1) Current varies with Output Data Rate (ODR) as shown, types and number of enabled digital engines, the average filter control settings, and VDD. Measured with OWUF [2:0] = 0, OSA [3:0] = 6, AVC [2:0] = 2.
(Note 2) For I²C communication, this assumes a minimum 1.5 kΩ pull-up resistor on SCL and SDA pins.

⁽Note 3) Start up time is from PC1 set to valid outputs. Time varies with ODR and Power Mode bit setting.

⁽Note 4) Power up time is from VDD valid to device boot completion.

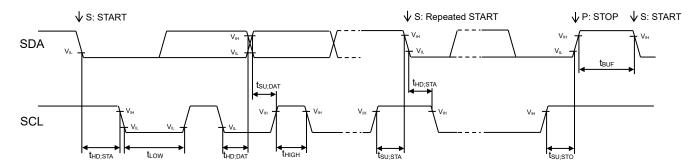
⁽Note 4) Power up unle is from VDD valid to device book completion.

(Note 5) Resolution and acceleration ranges are user selectable via I²C or SPI. Tolerance specified at ±1 g stimulus.

(Note 6) Signal bandwidth varies with Output Data Rate (ODR), and Low-pass filter setting.

(Note 7) Noise varies with ODR, power mode, settings. Measured with RES = 1, ODR = 50 Hz, IIR_BYPASS = 0, LPRO = 1 settings.

I²C Bus Timing Characteristics



(Unless otherwise specified V_{VDD} = 2.5 V, V_{IO_VDD} = 2.5 V, Ta = 25 °C)

| Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
|--------------------------------------|---------------------|-----|-----|-----|------|------------|
| SCL Clock frequency | f _{SCL} | 0 | - | 400 | kHz | |
| 'L' Period of SCL Clock | t _{LOW} | 1.3 | - | - | μs | |
| 'H' Period of SCL Clock | t _{HIGH} | 0.6 | - | - | μs | |
| Setup Time for Repeated START | tsu;sta | 0.6 | - | - | μs | |
| Hold Time for START | t _{HD;STA} | 0.6 | - | - | μs | |
| Data Setup Time | tsu;dat | 100 | - | - | ns | |
| Data Hold Time | t _{HD;DAT} | 0 | - | - | μs | |
| Setup Time for STOP | t _{su;sto} | 0.6 | - | - | μs | |
| Bus Free Time between STOP and START | t _{BUF} | 1.3 | - | - | μs | |

I²C Bus Communication

- 1. Write Format
 - (1) Indicate register address

| S | Target Address | W | ACK | Register Address | ACK | Р | |
|---|----------------|---|-----|------------------|-----|---|--|
|---|----------------|---|-----|------------------|-----|---|--|

(2) Write data after indicating register address

| S | Target Address | 0 | ACK | F | Register Address | ACK | | |
|---|--|-----|-----|-----|-----------------------|-----|-----|---|
| | Data specified at register address field | ACK | | ACK | Data specified at req | , | ACK | Р |

- 2. Read Format
 - (1) Read data after indicating register address

| S | Target Address | W 0 | ACK | F | Register Address | ACK | | |
|---|--|--------|-----|--|--|-----|------|---|
| S | Target Address | R 1 | ACK | Data specified at register address field | | ACK | | |
| | Data specified at register address field + 1 | | | ACK | Data specified at reg address field + N | | NACK | Р |

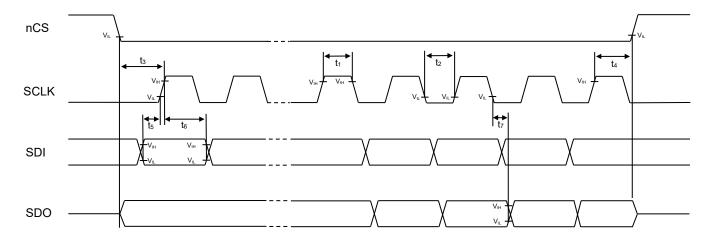
(2) Read data from the specified register

| S | Target Address | R 1 | ACK | Data | specified at register address field | ACK | | |
|---|--|--------|-----|------|---|-----|------|---|
| | Data specified at register address field + 1 | | | ACK | Data specified at re address field + l | | NACK | Р |
| | | | | | | | | |

| from Controller to Target | from Target to Controller |
|---------------------------|---------------------------|
| - | |

4-Wire SPI Bus Timing Characteristics

Timings are with 1 k Ω pull-up resistor and maximum 20 pF load capacitor on SDO. SCLK keeps HIGH when nCS is HIGH (no transmission). The MSB (Most Significant Bit) of the register address byte will indicate '0' when writing to the register and '1' when reading from the register. All commands are sent MSB first. The host must return nCS HIGH for at least one clock cycle(1/f_{SCLK}) before the next data request.

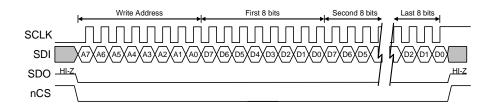


(Unless otherwise specified V_{VDD} = 2.5 V, V_{IO_VDD} = 2.5 V, Ta = 25 °C)

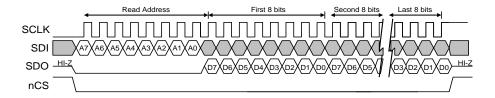
| Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
|--|-----------------------|-----|-----|-----|------|------------|
| SCLK Clock frequency | fsclk | - | - | 10 | MHz | |
| SCLK pulse width: HIGH | t ₁ | 45 | - | - | ns | |
| SCLK pulse width: LOW | t ₂ | 45 | - | - | ns | |
| nCS LOW to first SCLK rising edge | t ₃ | 20 | - | - | ns | |
| nCS LOW after the final SCLK rising edge to nCS HIGH | t ₄ | 20 | - | - | ns | |
| SDI valid to SCLK rising edge | t 5 | 10 | - | - | ns | |
| SCLK rising edge to SDI invalid | t 6 | 10 | - | - | ns | |
| SCLK falling edge to SDO valid ^(Note 1) | t ₇ | - | 35 | - | ns | |

(Note 1) Only present during reads.

1. Write Format

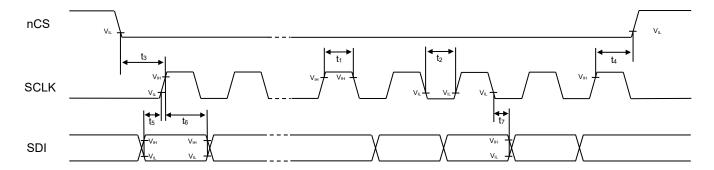


2. Read Format



3-Wire SPI Bus Timing Characteristics

Timings are with 1 k Ω pull-up resistor and maximum 20 pF load capacitor on SDI. SCLK keeps HIGH when nCS is HIGH (no transmission). The MSB (Most Significant Bit) of the register address byte will indicate '0' when writing to the register and '1' when reading from the register. All commands are sent MSB first. The host must return nCS HIGH for at least one clock cycle(1/f_{SCLK}) before the next data request. SDO/ADDR pin is configured in a high-impedance input-state, and must be externally tied to GND or IO VDD.

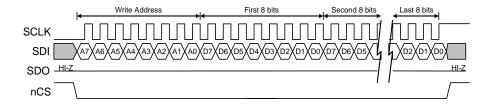


(Unless otherwise specified V_{VDD} = 2.5 V, V_{IO VDD} = 2.5 V, Ta = 25 °C)

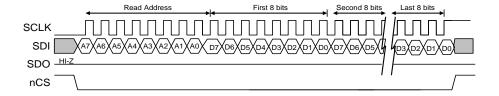
| Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
|---|-------------------|-----|-----|-----|------|------------|
| SCLK Clock frequency | f _{SCLK} | - | - | 10 | MHz | |
| SCLK pulse width: HIGH | t ₁ | 45 | - | - | ns | |
| SCLK pulse width: LOW | t ₂ | 45 | - | - | ns | |
| nCS LOW to first SCLK rising edge | t ₃ | 20 | - | - | ns | |
| nCS LOW after the final SCLK falling edge to nCS HIGH | t ₄ | 20 | - | - | ns | |
| SDI valid to SCLK rising edge | t ₅ | 10 | - | - | ns | |
| SCLK rising edge to SDI input invalid | t ₆ | 10 | - | - | ns | |
| SCLK falling edge to SDI output becomes valid ^(Note 1) | t ₇ | - | 35 | - | ns | |

(Note 1) Only present during reads.

1. Write Format



2. Read Format



Register Map(Note 1)

| Negistei | Map. | | | | | | | | | |
|---------------------|--------------------------|-----------|--------------|--------------|------------------|-----------------|-------------------|--------------|------------------|---------------|
| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 00h | XHPL | R | | | | XHF | 7 [7:0] | | | |
| 01h | XHPH | R | | | | XHP | [15:8] | | | |
| 02h | YHPL | R | | | | YHF | ? [7:0] | | | |
| 03h | YHPH | R | | | | YHP | [15:8] | | | |
| 04h | ZHPL | R | | ZHP [7:0] | | | | | | |
| 05h | ZHPH | R | | | | ZHP | [15:8] | | | |
| 06h | XOUTL | R | | | | XOU | T [7:0] | | | |
| 07h | XOUTH | R | | | | XOUT | [15:8] | | | |
| 08h | YOUTL | R | | | | YOU | T [7:0] | | | |
| 09h | YOUTH | R | | | | YOUT | [15:8] | | | |
| 0Ah | ZOUTL | R | | ZOUT [7:0] | | | | | | |
| 0Bh | ZOUTH | R | | ZOUT [15:8] | | | | | | |
| 0Ch | COTR | R | | | | СОТІ | R [7:0] | | | |
| 0Fh | WHO_AM_I | R/W | | | | WAI | [7:0] | | | |
| 10h | TSCP | R | 0 | 0 | LE | RI | DO | UP | FD | FU |
| 11h | TSPP | R | 0 | 0 | LE | RI | DO | UP | FD | FU |
| 12h | INS1 | R | 0 | 0 | TLE | TRI | TDO | TUP | TFD | TFU |
| 13h | INS2 | R | BTS | BFI | WMI | DRDY | TDTS | S [1:0] | WUFS | TPS |
| 14h | INS3 | R | 0 | 0 | XNWU | XPWU | YNWU | YPWU | ZNWU | ZPWU |
| 15h | STATUS_REG | R | PC1_ STAT | RES_ STAT | CRC_F | INT | POR_ STAT | STAT_ REG | Reserved | WAKE |
| 17h | INT_REL | R | | INT_REL | | | | | | |
| 18h | CNTL1 | R/W | PC1 | RES | DRDYE | GSEI | _ [1:0] | TDTE | WUFE | TPE |
| 19h | CNTL2 | R/W | SRST | СОТС | LEM | RIM | DOM | UPM | FDM | FUM |
| 1Ah | CNTL3 | R/W | ОТР | [1:0] | | OTDT [2:0] | | | OWUF [2:0] |] |
| lote 1) Do n | ot write any commands to | other add | esses excent | above Do not | write '1' to the | fields in which | n value is '0' in | ahove table | Do not write '0' | to the fields |

⁽Note 1) Do not write any commands to other addresses except above. Do not write '1' to the fields in which value is '0' in above table. Do not write '0' to the fields in which value is '1' in above table.

Register Map(Note 1) - continued

| Register | Map ^(Note 1) – continu | | | | | | | | | |
|----------|-----------------------------------|-----|----------------|------------|------------|----------------------------|----------|---------|--------------|---------------|
| Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 1Bh | ODCNTL | R/W | IIR_BYPA SS | LPRO | Rese | erved | | OSA | [3:0] | |
| 1Ch | INC1 | R/W | PW1 | [1:0] | IEN1 | IEA1 | IEL1 | 0 | STPOL | SPI3E |
| 1Dh | INC2 | R/W | 0 | AOI | XNWUE | XPWUE | YNWUE | YPWUE | ZNWUE | ZPWUE |
| 1Eh | INC3 | R/W | 0 | 0 | TLEM | TRIM | TDOM | TUPM | TFDM | TFUM |
| 1Fh | INC4 | R/W | FFI1 | BFI1 | WMI1 | 1 DRDYI1 BTSI1 TDTI1 WUFI1 | | | | |
| 20h | INC5 | R/W | PW2 | [1:0] | IEN2 | IEA2 | IEL2 | ACLR2 | ACLR1 | 0 |
| 21h | INC6 | R/W | FFI2 | BFI2 | WMI2 | DRDYI2 | BTSI2 | TDTI2 | WUFI2 | TPI2 |
| 22h | TILT_TIMER | R/W | | TSC [7:0] | | | | | | |
| 23h | WUFC | R/W | | | | WUF | C [7:0] | | | |
| 24h | TDTRC | R/W | 0 | 0 | 0 | 0 | 0 | 0 | DTRE | STRE |
| 25h | TDTC | R/W | | TDTC [7:0] | | | | | | |
| 26h | TTH | R/W | | TTH [7:0] | | | | | | |
| 27h | TTL | R/W | | | | TTL | [7:0] | | | |
| 28h | FTD | R/W | | | FTDH [4:0 |] | | | FTDL [2:0] | |
| 29h | STD | R/W | | | | STE | 7:0] | | | |
| 2Ah | TLT | R/W | | | | TLT | [7:0] | | | |
| 2Bh | TWS | R/W | | | | TWS | S [7:0] | | | |
| 2Ch | MAN_WAKE | W | 0 | 0 | 0 | 0 | 0 | 0 | MAN_WA KE | MAN_SLI EP |
| 2Dh | BTS_CNTL | R/W | BTSE | 0 | 0 | 0 | 0 | | OBTS [2:0 | |
| 2Eh | BTSC | R/W | | | | BTS | C [7:0] | | | |
| 2Fh | BTS_TH | R/W | | | | втѕт | H [7:0] | | | |
| 30h | WUF_TH | R/W | | | | WUF ⁻ | TH [7:0] | | | |
| 31h | BTS_WUF_TH | R/W | 0 | E | 3TSTH [10: | 8] | 0 | W | /UFTH [10: | 8] |
| 32h | TILT_ANGLE_LL | R/W | | | | LL | [7:0] | 1 | | |
| 33h | TILT_ANGLE_HL | R/W | | | | HL | [7:0] | | | |
| 34h | HYST_SET | R/W | Rese | erved | | | XEG | G [5:0] | | |
| 35h | LP_CNTL | R/W | 1 | | AVC [2:0] | | 1 | 0 | 1 | 1 |

⁽Note 1) Do not write any commands to other addresses except above. Do not write '1' to the fields in which value is '0' in above table. Do not write '0' to the fields in which value is '1' in above table.

Register Map^(Note 1) – continued

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
|---------------------|---------------|-----|--------------|---------------------------------|-----------------------------|--------|------------------------|----|----|-------|--|
| 36h | FFTH | R/W | | FFTH [7:0] | | | | | | | |
| 37h | FFC | R/W | | FFC [7:0] | | | | | | | |
| 38h | FFCNTL | R/W | FFIE | FFIE ULMODE 0 0 DCRM OFFI [2:0] | | | | | | | |
| 3Ah | BUF_CNTL1 | R/W | Reserved | Reserved SMP [6:0] | | | | | | | |
| 3Bh | BUF_CNTL2 | R/W | BUFE | BRES | BRES BFIE Reserved BM [1:0] | | | | | [1:0] | |
| 3Ch | BUF_STATUS_1 | R | | | | SMP_ | LV [7:0] | | | | |
| 3Dh | BUF_STATUS_2 | R | BUF_TRI G | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| 3Eh | BUF_CLEAR | W | | | | BUF_CL | EAR [7:0] | | | | |
| 3Fh | BUF_READ | R | | BUF_READ [7:0] | | | | | | | |
| 46h | BTS_WUF_CNTL | R/W | 0 | 0 TH_MOD C_MODE C_MODE 0 0 1 | | | | | | | |
| 60h | SELFTEST | W | | | | | EST [7:0] key = CAh |) | | | |

⁽Note 1) Do not write any commands to other addresses except above. Do not write '1' to the fields in which value is '0' in above table. Do not write '0' to the fields in which value is '1' in above table.

Register Map – continued (00h-05h) XHPL, XHPH, YHPL, YHPH, ZHPL, ZHPH

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
|---------------------|---------------|-----|----|------------|----|-----|--------|----|----|----|--|
| 00h | XHPL | R | | XHP [7:0] | | | | | | | |
| 01h | XHPH | R | | XHP [15:8] | | | | | | | |
| 02h | YHPL | R | | YHP [7:0] | | | | | | | |
| 03h | YHPH | R | | | | YHP | [15:8] | | | | |
| 04h | ZHPL | R | | ZHP [7:0] | | | | | | | |
| 05h | ZHPH | R | | ZHP [15:8] | | | | | | | |

| Fields | Function |
|--|---|
| XHP [15:0] YHP [15:0] ZHP [15:0] | High-pass filter accelerometer output. Data is updated at the ODR frequency determined by either OWUF in CNTL3 or OBTS in BTS_CNTL. |

(06h-0Bh) XOUTL, XOUTH, YOUTL, YOUTH, ZOUTL, ZOUTH

| (UOH-UDH) / | on-obn) XOUTE, XOUTH, YOUTE, YOUTH, ZOUTH | | | | | | | | | | |
|---------------------|---|-----|----|-------------|----|------|--------|----|----|----|--|
| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 06h | XOUTL | R | | XOUT [7:0] | | | | | | | |
| 07h | XOUTH | R | | XOUT [15:8] | | | | | | | |
| 08h | YOUTL | R | | YOUT [7:0] | | | | | | | |
| 09h | YOUTH | R | | | | YOUT | [15:8] | | | | |
| 0Ah | ZOUTL | R | | ZOUT [7:0] | | | | | | | |
| 0Bh | ZOUTH | R | | | | ZOUT | [15:8] | | | | |

| Fields | Function |
|---|---|
| XOUT [15:0] YOUT [15:0] ZOUT [15:0] | When accelerometer is enabled (the PC1 bit is set to 1 in CNTL1 register), the 16-bits of valid acceleration data for each axis is routed to registers. The output data is available in 2's complement data format. |

Data Format:

| 16-bit Register Data (2's complement) | Equivalent Counts in decimal | Acceleration Range = ±2 g | Acceleration Range = ±4 g | Acceleration Range = ±8 g | Acceleration Range = ±16 g |
|---|------------------------------------|---------------------------------|---------------------------------|---------------------------------|----------------------------------|
| 0111 1111 1111 1111 | +32767 | +1.99994 g | +3.99988 g | +7.99976 g | +15.99952 g |
| 0111 1111 1111 1110 | +32766 | +1.99988 g | +3.99976 g | +7.99952 g | +15.99904 g |
| | | | | | |
| 0000 0000 0000 0001 | +1 | +0.00006 g | +0.00012 g | +0.00024 g | +0.00048 g |
| 0000 0000 0000 0000 | 0 | 0.00000 g | 0.00000 g | 0.00000 g | 0.00000 g |
| 1111 1111 1111 1111 | -1 | -0.00006 g | -0.00012 g | -0.00024 g | -0.00048 g |
| | ••• | | | | |
| 1000 0000 0000 0001 | -32767 | -1.99994 g | -3.99988 g | -7.99976 g | -15.99952 g |
| 1000 0000 0000 0000 | -32768 | -2.00000 g | -4.00000 g | -8.00000 g | -16.00000 g |

| 8-bit Register Data (2's complement) | Equivalent Counts in decimal | Acceleration Range = ±2 g | Acceleration Range = ±4 g | Acceleration Range = ±8 g | Acceleration Range = ±16 g |
|--|------------------------------------|---------------------------------|---------------------------------|---------------------------------|----------------------------------|
| 0111 1111 | +127 | +1.98438 g | +3.96875 g | +7.93750 g | +15.87500 g |
| 0111 1110 | +126 | +1.96875 g | +3.93750 g | +7.87500 g | +15.75000 g |
| | | | | | |
| 0000 0001 | +1 | +0.01563 g | +0.03125 g | +0.06250 g | +0.12500 g |
| 0000 0000 | 0 | 0.00000 g | 0.00000 g | 0.00000 g | 0.00000 g |
| 1111 1111 | -1 | -0.01563 g | -0.03125 g | -0.06250 g | -0.12500 g |
| | | | | | |
| 1000 0001 | -127 | -1.98438 g | -3.96875 g | -7.93750 g | -15.87500 g |
| 1000 0000 | -128 | -2.00000 g | -4.00000 g | -8.00000 g | -16.00000 g |

(0Ch) COTR

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|---------|----|----|----|
| 0Ch | COTR | R | | | | COTF | R [7:0] | | | |

default value 55h

| Fields | Function |
|------------|--|
| COTR [7:0] | The Command Test Response (COTR) register is used to verify proper integrated circuit functionality. The value of this register will change from a default value of 55h to AAh when the COTC bit in CNTL2 register is set. After reading AAh from this register, the byte value returns to the default value of 55h and the COTC bit in CNTL2 register is cleared. |

(0Fh) WHO_AM_I

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 0Fh | WHO_AM_I | R/W | | | | WAI | [7:0] | | | |

default value C8h

| Fields | Function |
|-----------|---|
| WAI [7:0] | This register can be used for supplier recognition, as it can be factory written to a known byte value. The default value is C8h. |

(10h) TSCP

This register reports current position data that is updated at the user-defined ODR frequency determined by OTP [1:0] in CNTL3 register and is protected during register read. Following table describes the reported position for each bit value.

| Register | | <u> </u> | | - | | | | | | |
|----------|---------------|----------|----|----|----|----|----|----|----|----|
| Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 71001000 | | | | | | | | | | |
| 10h | TSCP | R | 0 | 0 | LE | RI | DO | UP | FD | FU |
| | | | | | | | | | | |

default value 20h

| Fields | Function |
|--------|----------------------|
| LE | Left State (X-) |
| RI | Right State (X+) |
| DO | Down State (Y-) |
| UP | Up State (Y+) |
| FD | Face-Down State (Z-) |
| FU | Face-Up State (Z+) |

(11h) TSPP

This register reports previous position data that is updated at the user-defined ODR frequency determined by OTP [1:0] in CNTL3 register and is protected during register read. Following table describes the reported position for each bit value.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|----|----|----|----|----|
| 11h | TSPP | R | 0 | 0 | LE | RI | DO | UP | FD | FU |

| Fields | Function |
|--------|----------------------|
| LE | Left State (X-) |
| RI | Right State (X+) |
| DO | Down State (Y-) |
| UP | Up State (Y+) |
| FD | Face-Down State (Z-) |
| FU | Face-Up State (Z+) |

(12h) INS1
This register indicates the triggering axis when a Single-tap/Double-tap interrupt occurs. Data is updated at the ODR settings determined by OTDT [2:0] in CNTL3. These bits are cleared when the interrupt latch release register (INT_REL) is read.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|-----|-----|-----|-----|-----|-----|
| 12h | INS1 | R | 0 | 0 | TLE | TRI | TDO | TUP | TFD | TFU |

| Fields | Function |
|--------|-------------------------|
| TLE | X Negative(X-) Reported |
| TRI | X Positive(X+) Reported |
| TDO | Y Negative(Y-) Reported |
| TUP | Y Positive(Y+) Reported |
| TFD | Z Negative(Z-) Reported |
| TFU | Z Positive(Z+) Reported |

(13h) INS2
This register tells which function caused an interrupt.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|-----|-----|-----|------|------|---------|------|-----|
| 13h | INS2 | R | BTS | BFI | WMI | DRDY | TDTS | S [1:0] | WUFS | TPS |

| Fields | Function |
|------------|---|
| BTS | Back-to-sleep interrupt. This bit is cleared when the interrupt latch release register INT_REL is read. BTS = 1 - Motion is below Back-to-sleep threshold. BTS = 0 - Motion is above Back-to-sleep threshold. |
| BFI | Buffer Full interrupt bit indicates that buffer has been filled. This bit is automatically cleared when at least one sample from the buffer is read. BFI = 0 - Buffer is not full. BFI = 1 - Buffer is full. |
| WMI | Watermark interrupt bit indicates that user-defined buffer's sample threshold, has been exceeded when in FIFO or Stream modes. Not used in Trigger mode. This bit is automatically cleared when buffer is read, and the content is below the watermark threshold as defined by SMP [6:0] in BUF_CNTL1 register. WMI = 0 - Buffer watermark has not been exceeded. WMI = 1 - Buffer watermark has been exceeded. |
| DRDY | Data Ready interrupt bit indicates that new acceleration data (06h to 0Bh) is available. This bit is cleared when acceleration data is read or the interrupt release register INT_REL is read. DRDY = 0 - New acceleration data is not available. DRDY = 1 - New acceleration data is available. |
| TDTS [1:0] | Status of Single-tap/Double-tap. This bit is released when interrupt release register INT_REL is read. TDTS [1:0] = 0 - No Tap events TDTS [1:0] = 1 - Single-tap TDTS [1:0] = 2 - Double-tap TDTS [1:0] = 3 - Undefined |
| WUFS | Wake-up interrupt. This bit is cleared when the interrupt latch release register INT_REL is read. WUFS = 1 - Motion is above Wake-up threshold. WUFS = 0 - Motion is below Wake-up threshold. |
| TPS | Tilt Position status. This bit is cleared when the interrupt release register INT_REL is read. TPS = 0 - Position is not changed. TPS = 1 - Position is changed. |

(14h) INS3

Motion Engine Interrupt Status register reports the axis and direction of detected motion that triggered the Wake-up interrupt. It also reports if Back-to-sleep interrupt was triggered.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|------|------|------|------|------|------|
| 14h | INS3 | R | 0 | 0 | XNWU | XPWU | YNWU | YPWU | ZNWU | ZPWU |

| Fields | Function |
|--------|--------------------------|
| XNWU | X Negative (X-) Reported |
| XPWU | X Positive (X+) Reported |
| YNWU | Y Negative (Y-) Reported |
| YPWU | Y Positive (Y+) Reported |
| ZNWU | Z Negative (Z-) Reported |
| ZPWU | Z Positive (Z+) Reported |

Register Map – continued (15h) STATUS_REG This register reports the status of the KX022ACR-Z.

Note that Sleep is the default state at power-up, shown in STATUS_REG register.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|--------------|--------------|-------|-----|--------------|--------------|----------|------|
| 15h | STATUS_REG | R | PC1_ STAT | RES_ STAT | CRC_F | INT | POR_ STAT | STAT_ REG | Reserved | WAKE |

| Fields | Function |
|----------|---|
| PC1_STAT | Reports if the PC1 bit in CNTL1 register is set. PC1_STAT = 0 - PC1 bit in CNTL1 register is not set. PC1_STAT = 1 - PC1 bit in CNTL1 register is set. |
| RES_STAT | Reports if the RES bit in CNTL1 register is set. RES_STAT = 0 - RES bit in CNTL1 register is not set. RES_STAT = 1 - RES bit in CNTL1 register is set. |
| CRC_F | Reports One Time Programmable (OTP) memory load failure. CRC_F = 0 - OTP load was successful. CRC_F = 1 - OTP load has failed. Perform Software Reset or Power Cycle the device. |
| INT | Reports the combined (OR) interrupt information according to interrupt setting. INT = 0 - No interrupt events were detected. INT = 1 - Interrupt event was detected. |
| POR_STAT | Reports the POR status of KX022ACR-Z. POR_STAT = 0 - No POR events. POR_STAT = 1 - POR event has occurred. Reading STATUS_REG automatically clears the POR_STAT bit. |
| STAT_REG | Reports whether KX022ACR-Z is running and sensing. STAT_REG = 0 - The accelerometer is either in Standby Mode or has detected that supplied VDD is below the minimum required, in which case the output data may not be valid. STAT_REG = 1 - The accelerometer is running and sensing. |
| WAKE | Reports the wake/back to sleep state. WAKE = 0 - KX022ACR-Z is in the Sleep state. WAKE = 1 - KX022ACR-Z is in the Wake state. Note that the WAKE bit just indicates the motion detection status, no KX022ACR-Z power mode changes. |

(17h) INT_REL

Latched interrupt source information is cleared, and physical interrupt latched pin is changed to its inactive state when this register is read. Read value is dummy.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|------|----|----|----|
| 17h | INT_REL | R | | | | INT_ | _REL | | | |

(18h) CNTL1
Read/write control register that provides more feature set control. Note that to change the value of this bit, the PC1 bit must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|-----|-----|-------|------|---------|------|------|-----|
| 18h | CNTL1 | R/W | PC1 | RES | DRDYE | GSEI | _ [1:0] | TDTE | WUFE | TPE |

| Fields | Function |
|------------|---|
| PC1 | Controls the operating mode of the KX022ACR-Z. When in RES = 0, allow 1.2/ODR delay time when transitioning from standby PC1 = 0 to operating mode. PC1 = 0 - Standby Mode PC1 = 1 - Low Power Mode or High Resolution Mode |
| RES | Determines the power mode of the KX022ACR-Z. The noise varies with ODR, RES and different LP_CNTL settings possibly reducing the effective resolution. RES = 0 - Low Power Mode if PC1 = 1 RES = 1 - High Resolution Mode if PC1 = 1 |
| DRDYE | Enables the reporting of the availability of new acceleration data as an interrupt. DRDYE = 0 - availability of new acceleration data is not reflected as an interrupt. DRDYE = 1 - availability of new acceleration data is reflected as an interrupt. |
| GSEL [1:0] | Selects the Acceleration Range of the accelerometer outputs. GSEL [1:0] = $0 - \pm 2$ g GSEL [1:0] = $1 - \pm 4$ g GSEL [1:0] = $2 - \pm 8$ g GSEL [1:0] = $3 - \pm 16$ g |
| TDTE | Enables the Directional Tap function that will detect Single-tap/Double-tap events. TDTE = 0 - The Directional Tap function is disabled. TDTE = 1 - The Directional Tap function is enabled. |
| WUFE | Enables the Wake-up (motion detect) function. WUFE = 0 - The Wake-up function is disabled. WUFE = 1 - The Wake-up function is enabled. |
| TPE | Enables the Tilt Position function that will detect changes in device orientation. TPE = 0 - The Tilt Position function is disabled. TPE = 1 - The Tilt Position function is enabled. |

(19h) CNTL2

Read/write control register that provides more feature set control. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

The LEM, RIM, DOM, UPM, FDM and FUM bits control the tilt axis mask. If a direction bit is set to '1', tilt in that direction will generate an interrupt. If it is set to '0', tilt in that direction will not generate an interrupt.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|------|------|-----|-----|-----|-----|-----|-----|
| 19h | CNTL2 | R/W | SRST | сотс | LEM | RIM | DOM | UPM | FDM | FUM |

default value 3Fh

| Fields | Function |
|--------|---|
| SRST | Initiates Software Reset, which performs the RAM reboot routine. This bit will remain 1 until the RAM reboot routine is finished with SPI reading. The KX022ACR-Z returns NACK with I ² C reading during the reboot routine. SRST = 0 - No action SRST = 1 - KX022ACR-Z starts the RAM reboot routine. |
| сотс | Command test control bit. COTC = 0 - No action COTC = 1 - The COTR register is set to AAh. The COTC bit automatically returns to '0' after the COTR reading. (The COTR is also returns to 55h) |
| LEM | X Negative (X-) Reported |
| RIM | X Positive (X+) Reported |
| DOM | Y Negative (Y-) Reported |
| UPM | Y Positive (Y+) Reported |
| FDM | Z Negative (Z-) Reported |
| FUM | Z Positive (Z+) Reported |

(1Ah) CNTL3
Read/write control register that provides more feature set control. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|-----|-------|----|------------|----|----|-----------|----|
| 1Ah | CNTL3 | R/W | ОТР | [1:0] | | OTDT [2:0] | | (| OWUF [2:0 |] |

default value A8h

| Fields | | | | | Function | 1 | |
|------------|--------------------------|---------|-------------|-------|-----------------|------------------------------|--|
| | Sets the our is 12.5 Hz. | | ita rate fo | r the | Tilt Position f | unction. The default Tilt Po | |
| | | ОТ | P [1] | ОТР | [0] | Output Data Rate | |
| OTP [1:0] | | | 0 | 0 | | 1.563 Hz | |
| 011 [1.0] | | | 0 | 1 | | 6.25 Hz | |
| | | | 1 | 0 | | 12.5 Hz | |
| | | | 1 | 1 | | 50 Hz | |
| | Tap ODR is | 400 H | Z. | | Ţ | ap function. The default Di | |
| | ОТІ | OT [2] | OTDT | [1] | OTDT [0] | Output Data Rate | |
| | | 0 | 0 | | 0 | 12.5 Hz | |
| OTDT [2:0] | | 0 | 0 | | 1 | 25 Hz | |
| | | 0 | 1 | | 0 | 50 Hz | |
| | | 0 | 1 | | 1 | 100 Hz | |
| | | 1 | 0 | | 0 | 200 Hz | |
| | | 1 | 0 | | 1 | 400 Hz | |
| | | 1 | 1 | | 0 | 800 Hz | |
| | | 1 | | | 1 | 1600 Hz | |
| | The defaul | t Wake- | up funct | on OI | DR is 0.781 H | T | |
| | OW | UF [2] | OWUI | - [1] | OWUF [0] | | |
| | | 0 | 0 | | 0 | 0.781 Hz | |
| | | 0 | 0 | | 1 | 1.563 Hz | |
| OWUF [2:0] | | 0 | 1 | | 0 | 3.125 Hz | |
| | | 0 | 1 | | 1 | 6.25 Hz | |
| | | 1 | 0 | | 0 | 12.5 Hz | |
| | | 1 | 0 | | 1 | 25 Hz | |
| | | 1 | 1 | | 0 | 50 Hz | |
| | | 4 | 1 | | 1 | 400 11- | |

100 Hz

(1Bh) ODCNTL

This register is responsible for configuring ODR (output data rate) and filter settings. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----------------|------|------|-------|----|-----|-------|----|
| 1Bh | ODCNTL | R/W | IIR_BYPA SS | LPRO | Rese | erved | | OSA | [3:0] | |

| Fields | | | | Fu | nction | | | | |
|------------|-----|--|------------|---------|---------|--|--|--|--|
| IIR_BYPASS | IIR | | | | | e accelerometer data path | | | |
| LPRO | LPI | The Low-pass filter roll off control LPRO = 0 - The corner frequency of the Low-pass filter is set to ODR/9. LPRO = 1 - The corner frequency of the Low-pass filter is set to ODR/2. | | | | | | | |
| | and | | Mode. This | | | Hz for both High Resolutional to or higher than enable | | | |
| | | OSA [3] | OSA [2] | OSA [1] | OSA [0] | Output Data Rate | | | |
| | | 0 | 0 | 0 | 0 | 0.781 Hz* | | | |
| | | 0 | 0 | 0 | 1 | 1.563 Hz* | | | |
| | | 0 | 0 | 1 | 0 | 3.125 Hz* | | | |
| | | 0 | 0 | 1 | 1 | 6.25 Hz* | | | |
| OSA [3:0] | | 0 | 1 | 0 | 0 | 12.5 Hz* | | | |
| | | 0 | 1 | 0 | 1 | 25 Hz* | | | |
| | | 0 | 1 | 1 | 0 | 50 Hz* | | | |
| | | 0 | 1 | 1 | 1 | 100 Hz* | | | |
| | | U | • | ! | ı . | 100 112 | | | |
| | | 1 | 0 | 0 | 0 | 200 Hz* | | | |
| | | • | | | - | | | | |
| | | 1 | 0 | 0 | 0 | 200 Hz* | | | |

(1Ch) INC1

This register controls the settings for the physical interrupt pin INT1. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|-----|-------|------|------|------|----|-------|-------|
| 1Ch | INC1 | R/W | PW1 | [1:0] | IEN1 | IEA1 | IEL1 | 0 | STPOL | SPI3E |

default value 10h

| Fields | Function |
|-----------|---|
| PW1 [1:0] | Pulse interrupt width configuration of the physical interrupt pin INT1. PW1 = 0 - 50 µs PW1 = 1 - OSA period PW1 = 2 - 2xOSA period PW1 = 3 - Reserved |
| IEN1 | Sets the enables/disables of the physical interrupt pin INT1. IEN1 = 0 - The physical interrupt pin is disabled. IEN1 = 1 - The physical interrupt pin is enabled. |
| IEA1 | Sets the polarity of the physical interrupt pin INT1. IEA1 = 0 - The polarity of the physical interrupt pin is set to active LOW. IEA1 = 1 - The polarity of the physical interrupt pin is set to active HIGH. |
| IEL1 | Sets the response of the physical interrupt pin INT1. IEL1 = 0 - The physical interrupt pin latches until it is cleared by reading INT_REL. IEL1 = 1 - The physical interrupt pin will transmit one pulse with a period of PW1. |
| STPOL | Sets the polarity of Self-test. STPOL = 1 - Negative STPOL = 0 - Positive |
| SPI3E | 3-wire SPI Interface Enable. SPI3E = 0 - KX022ACR-Z is set to 4-wire SPI mode. SPI3E = 1 - KX022ACR-Z is set to 3-wire SPI mode. |

(1Dh) INC2

This register controls which axis and direction of detected motion can cause an interrupt. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|-----|-------|-------|-------|-------|-------|-------|
| 1Dh | INC2 | R/W | 0 | AOI | XNWUE | XPWUE | YNWUE | YPWUE | ZNWUE | ZPWUE |

default value 3Fh

| Fields | Function |
|--------|--|
| AOI | AND-OR configuration on motion detection AOI = 0 - OR combination between selected directions AOI = 1 - AND combination between selected axes Ex. If all directions are enabled, Active state in OR configuration = (XN XP YN YP ZN ZP) Active state in AND configuration = (XN XP) & (YN YP) & (ZN ZP) |
| XNWUE | XNWUE = 0 - X negative(X-) is disabled. XNWUE = 1 - X negative(X-) is enabled. |
| XPWUE | XPWUE = 0 - X positive(X+) is disabled. XPWUE = 1 - X positive(X+) is enabled. |
| YNWUE | YNWUE = 0 - Y negative(Y-) is disabled. YNWUE = 1 - Y negative(Y-) is enabled. |
| YPWUE | YPWUE = 0 - Y positive(Y+) is disabled. YPWUE = 1 - Y positive(Y+) is enabled. |
| ZNWUE | ZNWUE = 0 - Z negative(Z-) is disabled. ZNWUE = 1 - Z negative(Z-) is enabled. |
| ZPWUE | ZPWUE = 0 - Z positive(Z+) is disabled. ZPWUE = 1 - Z positive(Z+) is enabled. |

(1Eh) INC3

This register controls which axis and direction of Single-tap/Double-tap can cause an interrupt. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|------|------|------|------|------|------|
| 1Eh | INC3 | R/W | 0 | 0 | TLEM | TRIM | TDOM | TUPM | TFDM | TFUM |

default value 3Fh

| Fields | Function |
|--------|--|
| TLEM | TLEM = 0 - X negative(X-) is disabled. TLEM = 1 - X negative(X-) is enabled. |
| TRIM | TRIM = 0 - X positive(X+) is disabled. TRIM = 1 - X positive(X+) is enabled. |
| TDOM | TDOM = 0 - Y negative(Y-) is disabled. TDOM = 1 - Y negative(Y-) is enabled. |
| TUPM | TUPM = 0 - Y positive(Y+) is disabled. TUPM = 1 - Y positive(Y+) is enabled. |
| TFDM | TFDM = 0 - Z negative(Z-) is disabled. TFDM = 1 - Z negative(Z-) is enabled. |
| TFUM | TFUM = 0 - Z positive(Z+) is disabled. TFUM = 1 - Z positive(Z+) is enabled. |

(1Fh) INC4

This register controls routing of an interrupt reporting to physical interrupt pin INT1. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|------|------|------|--------|-------|-------|-------|------|
| 1Fh | INC4 | R/W | FFI1 | BFI1 | WMI1 | DRDYI1 | BTSI1 | TDTI1 | WUFI1 | TPI1 |

| Fields | Function |
|--------|--|
| FFI1 | Free fall interrupt reported on physical interrupt pin INT1. |
| BFI1 | Buffer full interrupt reported on physical interrupt pin INT1. |
| WMI1 | Watermark interrupt reported on physical interrupt pin INT1. |
| DRDYI1 | Data ready interrupt reported on physical interrupt pin INT1. |
| BTSI1 | Back-to-sleep (motion detect) interrupt reported on physical interrupt pin INT1. |
| TDTI1 | Single-tap/Double-tap interrupt reported on physical interrupt pin INT1. |
| WUFI1 | Wake-up (motion detect) interrupt reported on physical interrupt pin INT1. |
| TPI1 | Tilt position interrupt reported on physical interrupt pin INT1. |

(20h) INC5

This register controls the settings for the physical interrupt pin INT2. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|-----|--------|------|------|------|-------|-------|----|
| 20h | INC5 | R/W | PW2 | 2[1:0] | IEN2 | IEA2 | IEL2 | ACLR2 | ACLR1 | 0 |

default value 10h

| Fields | Function |
|-----------|---|
| PW2 [1:0] | Pulse interrupt width configuration of the physical interrupt pin INT2. PW2 = 0 - 50 µs PW2 = 1 - OSA period PW2 = 2 - 2xOSA period PW2 = 3 - Reserved |
| IEN2 | Enables/disables the physical interrupt pin INT2. IEN2 = 0 - The physical interrupt pin is disabled. IEN2 = 1 - The physical interrupt pin is enabled. |
| IEA2 | Sets the polarity of the physical interrupt pin INT2. IEA2 = 0 - The polarity of the physical interrupt pin is set to active LOW. IEA2 = 1 - The polarity of the physical interrupt pin is set to active HIGH. |
| IEL2 | Sets the response of the physical interrupt pin INT2. IEL2 = 0 - The physical interrupt pin latches until it is cleared by reading INT_REL. IEL2 = 1 - The physical interrupt pin will transmit one pulse with a period of PW2. |
| ACLR2 | INT2 auto interrupt latch clear for Free Fall, Single-tap/Double-tap, Tilt, WUF, and BTS. ACLR2 = 0 - Latched interrupt is not automatically cleared. ACLR2 = 1 - Latched interrupt is automatically cleared at pulse interrupt-2 trailing edge if IEL2 = 1. |
| ACLR1 | INT1 auto interrupt latch clear for Free Fall, Single-tap/Double-tap, Tilt, WUF, and BTS. ACLR1 = 0 - Latched interrupt is not automatically cleared. ACLR1 = 1 - Latched interrupt is automatically cleared at pulse interrupt-1 trailing edge if IEL1 = 1 in INC1 register. |

(21h) INC6

This register controls routing of interrupt reporting to physical interrupt pin INT2. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|------|------|------|--------|-------|-------|-------|------|
| 21h | INC6 | R/W | FFI2 | BFI2 | WMI2 | DRDYI2 | BTSI2 | TDTI2 | WUFI2 | TPI2 |

| Fields | Function |
|--------|--|
| FFI2 | Free fall interrupt reported on physical interrupt pin INT2. |
| BFI2 | Buffer full interrupt reported on physical interrupt pin INT2. |
| WMI2 | Watermark interrupt reported on physical interrupt pin INT2. |
| DRDYI2 | Data ready interrupt reported on physical interrupt pin INT2. |
| BTSI2 | Back-to-sleep (motion detect) interrupt reported on physical interrupt pin INT2. |
| TDTI2 | Single-tap/Double-tap interrupt reported on physical interrupt pin INT2. |
| WUFI2 | Wake-up (motion detect) interrupt reported on physical interrupt pin INT2. |
| TPI2 | Tilt position interrupt reported on physical interrupt pin INT2. |

(22h) TILT_TIMER

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 22h | TILT_TIMER | R/W | | | | TSC | [7:0] | | | |

default value 00h

| Fields | Function |
|-----------|---|
| TSC [7:0] | This register is the initial count register for the tilt position state timer (0 to 255 counts). Every count is calculated as 1/ODR delay period, where the ODR is defined by OTP [1:0] in CNTL3 register. A new state must be valid as many measurement periods before the change is accepted. |

(23h) WUFC

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|---------|----|----|----|
| 23h | WUFC | R/W | | | | WUF | C [7:0] | | | |

default value 00h

| Fields | Function |
|------------|--|
| WUFC [7:0] | This register is the debounce count register for the motion detection timer (0 to 255 counts). Every count is calculated as 1/ODR delay period, where the ODR is defined by OWUF [2:0] in CNTL3 register. The WUFC counter starts the count when the motion exceeds the threshold set by WUFTH [10:0] in WUF_TH & BTS_WUF_TH registers. The count continues as long as this condition remains valid. When the count completes, a Wake-up event is considered to be detected. |

(24h) TDTRC

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|----|----|----|------|------|
| 24h | TDTRC | R/W | 0 | 0 | 0 | 0 | 0 | 0 | DTRE | STRE |

| Fields | Function |
|--------|---|
| DTRE | Enables/disables the Double-tap interrupt DTRE = 0 - The Double-tap events don't update/trigger interrupt. DTRE = 1 - The Double-tap events update/trigger interrupt. |
| STRE | Enables/disables Single-tap interrupt STRE = 0 - The Single-tap events don't update/trigger interrupt. STRE = 1 - The Single-tap events update/trigger interrupt. |

(25h) TDTC

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|-------|----|----|----|
| 25h | TDTC | R/W | | | | TDTC | [7:0] | | | |

default value 78h

| Fields | Function |
|------------|---|
| TDTC [7:0] | This register contains counter information for the detection of a Double-tap event. When the Directional Tap ODR is 400 Hz or less, every count is calculated as 1/ODR delay period. When the Directional Tap ODR is 800 Hz, every count is calculated as 2/ODR delay period. When the Directional Tap ODR is 1600 Hz, every count is calculated as 4/ODR delay period. The Directional Tap ODR is defined by OTDT [2:0] in CNTL3 register. The TDTC counts starts at the beginning of the first tap and it represents the minimum time separation between the first tap and the second tap in a Double-tap event. More specifically, the second tap event must end outside of the TDTC. The Rohm recommended default value is 0.3 seconds (78h). |

(26h) TTH

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 26h | TTH | R/W | | | | TTH | [7:0] | | | |

default value CBh

| Fields | Function |
|-----------|---|
| TTH [7:0] | This register represents the 8-bit jerk high threshold to determine if a tap is detected. The value is compared against the upper 8 bits of the 8 g output value (independent of the actual g-range setting of the device). Though this is an 8-bit register, the register value is internally multiplied by two in order to set the high threshold. This multiplication results in a range of 0 to 510 with a resolution of two counts. The Performance Index (PI) is the jerk signal that is expected to be less than this threshold, but greater than the TTL threshold during Single-tap/Double-tap events. The Rohm recommended default value is 203 (CBh) and the Performance Index is calculated as: $X' = X \text{ (current)} - X \text{ (previous)}$ $Y' = Y \text{ (current)} - Y \text{ (previous)}$ $Z' = Z \text{ (current)} - Z \text{ (previous)}$ $PI = X' + Y' + Z' $ |

(27h) TTL

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 27h | TTL | R/W | | | | TTL | [7:0] | | | |

default value 1Ah

| Fields | Function |
|-----------|--|
| TTL [7:0] | This register represents the 8-bit (0 - 255) jerk low threshold to determine if a tap is detected. The value is compared against the upper 8 bits of the 8 g output value (independent of the actual g-range setting of the device). The Performance Index (PI) is the jerk signal that is expected to be greater than this threshold and less than the TTH threshold during Single-tap/Double-tap events. The Rohm recommended default value is 26 (1Ah). |

(28h) FTD

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|------------|----|----|----|------------|----|
| 28h | FTD | R/W | | | FTDH [4:0] | | | | FTDL [2:0] | |

default value A2h

| Fields | Function |
|--------------------------|--|
| FTDH [4:0] FTDL [2:0] | This register contains counter information for the detection of any tap event. When the Directional Tap ODR is 400 Hz or less, every count is calculated as 1/ODR delay period. When the Directional Tap ODR is 800 Hz, every count is calculated as 2/ODR delay period. When the Directional Tap ODR is 1600 Hz, every count is calculated as 4/ODR delay period. The Directional Tap ODR is defined by OTDT [2:0] in CNTL3 register. In order to ensure that only tap events are detected, these time limits are used. A tap event must be above the performance index threshold for at least the low limit (FTDL0 - FTDL2) and no more than the high limit (FTDH0 - FTDH4). The Rohm recommended default value for the high limit is 0.05 seconds and for the low limit is 0.005 seconds (A2h). |

(29h) STD

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 29h | STD | R/W | | | | STD | [7:0] | | | |

default value 24h

| Fields | Function |
|-----------|---|
| STD [7:0] | This register contains counter information for the detection of a Double-tap event. When the Directional Tap ODR is 400 Hz or less, every count is calculated as 1/ODR delay period. When the Directional Tap ODR is 800 Hz, every count is calculated as 2/ODR delay period. When the Directional Tap ODR is 1600 Hz, every count is calculated as 4/ODR delay period. The Directional Tap ODR is defined by OTDT [2:0] in CNTL3 register. In order to ensure that only tap events are detected, this time limit is used. This register sets the total amount of time that the two taps in a Double-tap event can be above the PI threshold (TTL). The Rohm recommended default value for STD is 0.09 seconds (24h). |

(2Ah) TLT

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 2Ah | TLT | R/W | | | | TLT | [7:0] | | | |

default value 28h

| Fields | Function |
|-----------|--|
| TLT [7:0] | This register contains counter information for the detection of a tap event. When the Directional Tap ODR is 400 Hz or less, every count is calculated as 1/ODR delay period. When the Directional Tap ODR is 800 Hz, every count is calculated as 2/ODR delay period. When the Directional Tap ODR is 1600 Hz, every count is calculated as 4/ODR delay period. The Directional Tap ODR is defined by OTDT [2:0] in CNTL3 register. In order to ensure that only tap events are detected, this time limit is used. This register sets the total amount of time that the tap algorithm will count samples that are above the PI threshold (TTL) during a potential tap event. It is used during both Single-tap/Double-tap events. However, reporting of Single-tap events on the physical interrupt pin INT1 or INT2 will occur at the end of the TWS. The Rohm recommended default value for TLT is 0.1 seconds (28h). |

(2Bh) TWS

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 2Bh | TWS | R/W | | | | TWS | [7:0] | | | |

default value A0h

| Fields | Function |
|-----------|---|
| TWS [7:0] | This register contains counter information for the detection of Single-tap/Double-tap events. When the Directional Tap ODR is 400 Hz or less, every count is calculated as 1/ODR delay period. When the Directional Tap ODR is 800 Hz, every count is calculated as 2/ODR delay period. When the Directional Tap ODR is 1600 Hz, every count is calculated as 4/ODR delay period. The Directional Tap ODR is defined by OTDT [2:0] in CNTL3 register. It defines the time window for the entire tap event, single or double, to occur. Reporting of Single-tap events on the physical interrupt pin INT1 or INT2 will occur at the end of this tap window. The Rohm recommended default value for TWS is 0.4 seconds (A0h). |

(2Ch) MAN_WAKE

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|----|----|----|--------------|---------------|
| 2Ch | MAN_WAKE | W | 0 | 0 | 0 | 0 | 0 | 0 | MAN_WA KE | MAN_SLE EP |

| Fields | Function |
|-----------|---|
| MAN_WAKE | Manual wake-sleep engine overwrite MAN_WAKE = 0 - No action MAN_WAKE = 1 - The wake state is forced to WAKE state. (The MAN_WAKE bit is self-cleared) |
| MAN_SLEEP | Manual wake-sleep engine overwrite MAN_SLEEP = 0 - No action MAN_SLEEP = 1 - The wake state is forced to SLEEP state. (The MAN_SLEEP bit is self-cleared) |

(2Dh) BTS_CNTL

Note that to change the value of this bit, the PC1 bit must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|------|----|----|----|----|----|------------|----|
| 2Dh | BTS_CNTL | R/W | BTSE | 0 | 0 | 0 | 0 | | OBTS [2:0] | |

default value 00h

| Fields | | | | Function | า | | | | | |
|------------|------|--|----------|----------------|------------------------------------|--|--|--|--|--|
| BTSE | BTSE | Enables the Back-to-sleep function. BTSE = 0 - Back-to-sleep function is disabled. BTSE = 1 - Back-to-sleep function is enabled. | | | | | | | | |
| | | the output da lefault ODR is | | e Back-to-slee | p and the High-pass filter outputs | | | | | |
| | | OBTS [2] | OBTS [1] | OBTS [0] | Output Data Rate | | | | | |
| | | 0 | 0 | 0 | 0.781 Hz | | | | | |
| | | 0 | 0 | 1 | 1.563 Hz | | | | | |
| OBTS [2:0] | | 0 | 1 | 0 | 3.125 Hz | | | | | |
| | | 0 | 1 | 1 | 6.25 Hz | | | | | |
| | | 1 | 0 | 0 | 12.5 Hz | | | | | |
| | | 1 | 0 | 1 | 25 Hz | | | | | |
| | | 1 | 1 | 0 | 50 Hz | | | | | |
| | | | | l | | | | | | |

(2Eh) BTSC

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|---------|----|----|----|
| 2Eh | BTSC | R/W | | | | BTSC | C [7:0] | | | |

| Fields | Function |
|------------|---|
| BTSC [7:0] | This register is the debounce count register for the motion detection timer (0 to 255 counts). Every count is calculated as 1/ODR delay period, where the ODR is defined by OBTS [2:0] in BTS_CNTL register. The BTSC counter starts the count when the motion drops below the threshold set by BTSTH [10:0] in BTS_TH & BTS_WUF_TH registers. The count continues as long as this condition remains valid. When the count completes, a Back-to-sleep event is considered to be detected. |

Register Map – continued (2Fh-31h) BTS_TH, WUF_TH, BTS_WUF_TH Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Address | | | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|----------|-----|----|----|-------|---------|----|----|----|
| 2Fh | BTS_TH F | R/W | | | BTSTI | H [7:0] | | | |

default value 80h

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|---------|----|----|----|
| 30h | WUF_TH | R/W | | | | WUFT | H [7:0] | | | |

default value 80h

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|-----------|----|----|----|------------|----|
| 31h | BTS_WUF_TH | R/W | 0 | В | TSTH [10: | 8] | 0 | W | 'UFTH [10: | 8] |

default value 00h

| Fields | Function |
|--------------|--|
| BTSTH [10:0] | This register sets the threshold for Back-to-sleep (motion detect) interrupt is set. The KX022ACR-Z will ship from the factory with this value set to correspond to a change in acceleration of 0.5 g. |

| Fields | Function |
|--------------|--|
| WUFTH [10:0] | This register sets the threshold for Wake-up (motion detect) interrupt is set. The KX022ACR-Z will ship from the factory with this value set to correspond to a change in acceleration of 0.5 g. |

(32h-33h) TILT_ANGLE_LL, TILT_ANGLE_HL

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|------|----|----|----|
| 32h | TILT_ANGLE_LL | R/W | | | | LL [| 7:0] | | | |

default value 0Ch

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|-------|----|----|----|
| 33h | TILT_ANGLE_HL | R/W | | | | HL [| [7:0] | | | |

default value 2Ah

| Fields | Function |
|----------|--|
| LL [7:0] | This register sets the low level threshold for tilt angle detection. The low level threshold value is compared against the upper 8 bits of the 8 g output value (independent of the actual g-range setting of the device). The KX022ACR-Z ships from the factory with tilt angle set to a low threshold of 22° from horizontal. A different default tilt angle can be requested from the factory. Note that the minimum suggested tilt angle is 10°. |

| Fields | Function |
|----------|--|
| HL [7:0] | This register sets the high level threshold for tilt angle detection. The high level threshold value is compared against the upper 8 bits of the 8 g output value (independent of the actual g-range setting of the device). |

(34h) HYST_SET

Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|------|----------|----|----|-----|-------|----|----|
| 34h | HYST_SET | R/W | Rese | Reserved | | | XEG | [5:0] | | |

default value 14h

| Fields | Function |
|-----------|--|
| XEG [5:0] | This register sets the Hysteresis that is placed in between the Screen Rotation states. The KX022ACR-Z ships from the factory with HYST_SET set to ±15° of hysteresis. |

(35h) LP_CNTL

Low Power Control sets the number of samples of accelerometer output to be averaged. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|-----------|----|----|----|----|----|
| 35h | LP_CNTL | R/W | 1 | | AVC [2:0] | | 1 | 0 | 1 | 1 |

default value CBh

| Fields | | Function | | | | | | | | |
|-------------|----------|-------------|----------------|------------------|------------------------|--|--|--|--|--|
| | Averagin | g Filter Co | ontrol, the de | fault setting is | s 16 samples averaged. | | | | | |
| | A | VC [2] | AVC [1] | AVC [0] | Number of Averaging | | | | | |
| | | 0 | 0 | 0 | Reserved | | | | | |
| | | 0 | 0 | 1 | 2 Samples Averaged | | | | | |
| AVC [2:0] | | 0 | 1 | 0 | 4 Samples Averaged | | | | | |
| / W O [2.0] | | 0 | 1 | 1 | 8 Samples Averaged | | | | | |
| | | 1 | 0 | 0 | 16 Samples Averaged | | | | | |
| | | 1 | 0 | 1 | 32 Samples Averaged | | | | | |
| | | 1 | 1 | 0 | 64 Samples Averaged | | | | | |
| | | 1 | 1 | 1 | 128 Samples Averaged | | | | | |

(36h) FFTH

Note that to properly change the value of this register, the PC1 bit in CNTL1 register must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|------|---------|----|----|----|
| 36h | FFTH | R/W | | | | FFTH | l [7:0] | | | |

| Fields | Function |
|------------|--|
| FFTH [7:0] | The Free Fall Threshold (FFTH) register contains the threshold of the Free fall detection. This value is compared to the top 8 bits of the accelerometer 8 g output value (independent of the actual g-range setting of the device). |

(37h) FFC

Note that to properly change the value of this register, the PC1 bit in CNTL1 register must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|-----|-------|----|----|----|
| 37h | FFC | R/W | | | | FFC | [7:0] | | | |

default value 00h

| Fields | Function |
|-----------|---|
| FFC [7:0] | The Free Fall Counter (FFC) register contains the counter setting of the Free fall detection. Every count is calculated as 1/ODR delay period where ODR is a Free fall ODR set by OFFI [2:0] bits in FFCNTL register. |

(38h) FFCNTL

The Free Fall Control (FFCNTL) register contains the control setting of the Free fall detection. Note that to properly change the value of this register, the PC1 bit in CNTL1 register must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|------|--------|----|----|------|------------|----|----|
| 38h | FFCNTL | R/W | FFIE | ULMODE | 0 | 0 | DCRM | OFFI [2:0] | | |

| Fields | | | | Functio | on | | | | | |
|------------|-------|--|---------------|--|---|--|--|--|--|--|
| FFIE | FFIE: | e the Free fa = 0 - The Fre = 1 - The Fre | e fall engine | | | | | | | |
| ULMODE | ULMC | | Fee fall inte | control rrupt is latch errupt is not l | | | | | | |
| DCRM | DCRN | Free fall debounce methodology control DCRM = 0 - The Free fall counter is set to count up/down. DCRM = 1 - The Free fall counter is set to count up/reset. | | | | | | | | |
| | | of Data Rate of the state of th | | | ne performs its function. Output Data Rate | | | | | |
| | | 0 | 0 | 0 | 12.5 Hz | | | | | |
| | | 0 | 0 | 1 | 25 Hz | | | | | |
| OFFI [2:0] | | 0 | 1 | 0 | 50 Hz | | | | | |
| | | 0 | 1 | 1 | 100 Hz | | | | | |
| | | 1 | 0 | 0 | 200 Hz | | | | | |
| | | 1 | 0 | 1 | 400 Hz | | | | | |
| | | 1 | 1 | 0 | 800 Hz | | | | | |
| | | 1 | 1 | 1 | 1600 Hz | | | | | |

(3Ah) BUF_CNTL1

Read/write control register that controls the buffer sample threshold. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----------|----|----|----|-----------|----|----|----|
| 3Ah | BUF_CNTL1 | R/W | Reserved | | | | SMP [6:0] | | | |

default value 00h

| Fields | Function |
|-----------|---|
| SMP [6:0] | Determines the number of samples that will trigger a watermark interrupt or will be saved prior to a trigger event. When BRES = 1, the maximum number of samples is 43; when BRES = 0, the maximum number of samples is 86. In the case of FIFO, Stream and FILO mode, SMP specifies how many buffer samples are needed to trigger a watermark interrupt. In the case of Trigger mode, SMP specifies how many buffer samples before the trigger event are retained in the buffer. |

(3Bh) BUF_CNTL2

Read/write control register that controls sample buffer operation. Note that to properly change the value of this register, the PC1 bit in CNTL1 must first be set to '0'.

| Register Address | | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|-----------|-----|------|------|------|----------|----|----|-------|----|
| 3Bh | BUF_CNTL2 | R/W | BUFE | BRES | BFIE | Reserved | | ВМ | [1:0] | |

| Fields | | | | Function | | | | | | |
|----------|--------------------------------|---|------------|---|--|--|--|--|--|--|
| BUFE | | - The sam | ple buffer | ole buffer. is disabled. is enabled. | | | | | | |
| BRES | buffer. BRES = 0 | Determines the resolution of the acceleration data samples collected by the sample buffer. BRES = 0 - 8-bits samples are accumulated in the buffer. BRES = 1 - 16-bits samples are accumulated in the buffer. | | | | | | | | |
| BFIE | BFIE = 0 - | Buffer full interrupt enable. BFIE = 0 - The buffer full interrupt is disabled. BFIE = 1 - The buffer full interrupt is enabled. | | | | | | | | |
| | Selects the | e operatino | g mode of | the sample buffer. | | | | | | |
| | BM [1] BM [0] Mode Description | | | | | | | | | |
| | 0 | 0 | FIFO | The buffer collects 86 sets of 8-bit low resolution values or 43 sets of 16-bit high resolution values and then stops collecting data, collecting new data only when the buffer is not full. | | | | | | |
| BM [1:0] | 0 | 1 | Stream | The buffer holds the last 86 sets of 8-bit low resolution values or 43 sets of 16-bit high resolution values. Once the buffer is full, the oldest data is discarded to make room for newer data. | | | | | | |
| | 1 | 0 | Trigger | When a trigger event occurs, the buffer holds the last data set of SMP [6:0] samples before the trigger event and then continues to collect data until full. New data is collected only when the buffer is not full. | | | | | | |
| | 1 | 1 | FILO | The buffer holds the last 86 sets of 8-bit low resolution values or 43 sets of 16-bit high resolution values. Once the buffer is full, the oldest data is discarded to make room for newer data. Reading from the buffer in this mode will return the most recent data first. | | | | | | |

Register Map – continued
(3Ch) BUF_STATUS_1
This register reports the status of the sample buffer.

| Tills regist | no register reports the status of the sample barrer. | | | | | | | | | | | |
|---------------------|--|-----|----|----|----|-------|----------|----|----|----|--|--|
| Register Address | | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | |
| 3Ch | BUF_STATUS_1 | R | | | | SMP_L | _V [7:0] | | | | | |

| Fields | Function |
|--------------|--|
| SMP_LV [7:0] | Reports the number of data bytes that have been stored in the sample buffer. When BRES = 1, this count will increase by 6 for each 3-axis sample in the buffer; when BRES = 0, the count will increase by 3 for each 3-axis sample. If this register reads 0, no data has been stored in the buffer. |

(3Dh) BUF_STATUS_2
This register reports the status of the sample buffer trigger function.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|--------------|----|----|----|----|----|----|----|
| 3Dh | BUF_STATUS_2 | R | BUF_TRI G | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

| Fields | Function |
|----------|--|
| BUF_TRIG | Reports the status of the buffer's trigger function if this mode has been selected. When using trigger mode, a buffer read should only be performed after a trigger event. |

(3Eh) BUF_CLEAR

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|---------|-----------|----|----|----|
| 3Eh | BUF_CLEAR | W | | | | BUF_CLI | EAR [7:0] | | | |

default value 00h

| Fields | Function |
|-----------------|---|
| BUF_CLEAR [7:0] | Latched buffer status information and the entire sample buffer are cleared when any data is written to this register. |

(3Fh) BUF_READ

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|----|----|--------|----------|----|----|----|
| 3Fh | BUF_READ | R | | | | BUF_RE | AD [7:0] | | | |

| Fields | Function |
|----------------|---|
| BUF_READ [7:0] | Buffer output register. Note, new data is not being written to the buffer during the buffer read operation. Thus, care must be taken when reading from the buffer. If data loss is not desired, the buffer read operation should be completed within ODR cycle. |

(46h) BTS_WUF_CNTL

This register controls WUF/BTS engine mode.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|----|-------------|----------------|----------------|----|----|----|----|
| 46h | BTS_WUF_CNTL | R/W | 0 | TH_MOD E | C_MODE _BTS | C_MODE _WUF | 0 | 0 | 0 | 1 |

default value 41h

| Fields | Function |
|------------|--|
| TH_MODE | Determines the threshold mode of Wake-up function/Back-to-sleep engine. TH_MODE = 0 - Engine is set to absolute threshold mode. TH_MODE = 1 - Engine is set to relative threshold mode. |
| C_MODE_BTS | Determines the Back-to-sleep debounce counter mode. C_MODE_BTS = 0 - The Back-to-sleep debounce counter is set to count up/reset. C_MODE_BTS = 1 - The Back-to-sleep debounce counter is set to count up/down. |
| C_MODE_WUF | Determines the Wake-up function debounce counter mode. C_MODE_WUF = 0 - The Wake-up function debounce counter is count up/reset. C_MODE_WUF = 1 - The Wake-up function debounce counter is count up/down. |

(60h) SELFTEST

Self-test Enable register.

| Register Address | Register Name | R/W | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------------------|---------------|-----|--|----|----|----|----|----|----|----|
| 60h | SELFTEST | W | SELFTEST [7:0] (activation key = CAh) | | | | | | | |

| Fields | Function |
|----------------|---|
| SELFTEST [7:0] | Writing activation key (CAh) causes the KX022ACR-Z into the Self-test mode. |

To perform the Self-test, the following procedure is required:

- (1) Set the PC1 bit to '0' in CNTL1 register to disable KX022ACR-Z.
- (2) Write CAh to this register to enable the MEMS Self-test function.
- (3) Set the PC1 bit to '1' in CNTL1 register to enable KX022ACR-Z.

Once the Self-test function is enabled, electrostatic-actuation of the accelerometer, results in a DC shift of the X, Y and Z axis outputs. Calculate the Self-test (ST) response.

ST [g] = (OUTPUT_ST_ON [counts] - OUTPUT_ST_OFF [counts]) / Sensitivity [counts/g]

The Self-test response should be compared to the product specifications to determine if the MEMS response is within the specified range (see the Electrical Characteristic table).

To disable the Self-test mode, any of the following methods can be used:

- Power cycle KX022ACR-Z.
- Perform Software Reset by setting SRST bit to 1 in CNTL2 register.
- Set the PC1 bit to 0 in CNTL1 register. Then, write 00h to this register to disable the Self-test mode.

Motion Interrupt

KX022ACR-Z features an advanced threshold interrupt by the internal Wake-up and Back-to-sleep digital engines. These engines allow the KX022ACR-Z to trigger interrupts when accelerometer activity falls below a defined threshold window (Back-to-sleep) or exceeds a threshold window (Wake-up event). Note that this function only generates an interrupt and doesn't trigger any changes to the part configuration (e.g. power mode, ODR, etc.).

1. Enabling/Disabling

The Wake-up and Back-to-sleep detection can be enabled/disabled using WUFE bit in CNTL1 and BTSE bit in BTS_CNTL register and the direction of motion detection can be set for any axis in INC2 register.

2. Debounce Counter

The Wake-up and Back-to-sleep digital engines have an internal debounce counter to qualify motion status detection. The debounce counter function can be set using either C_MODE_BTS or C_MODE_WUF bit in BTS_WUF_CNTL register. The counter can be configured to either reset or decrement itself if accelerometer data has either fallen below or risen above the threshold for Wake-up or Back-to-sleep functionality respectively. Note that each Wake-up Function Counter (WUFC) count qualifies 1 (one) user-defined Wake-up Function ODR period as set by OWUF [2:0] bits in CNTL3 register. Similarly, each Back-to-sleep Counter (BTSC) count qualifies 1 (one) user-defined Back-to-sleep function ODR period as set by OBTS [2:0] bits in BTS_CNTL register. Following equation shows how to calculate the WUFC and BTSC register values for a desired Wake-up and Back-to-sleep delay times.

WUFC (counts) = Wake-up Delay Time (s) x Wake-up Function ODR (Hz) BTSC (counts) = Back-to-sleep Delay Time (s) x Back-to-sleep Function ODR (Hz)

3. Threshold Resolution

The motion interrupt threshold values are set by WUFTH [10:0] and BTSTH [10:0] bits in BTS_TH, WUF_TH and BTS_WUF_TH registers. The values in these registers are compared to the top 11 bits of the accelerometer 8 g output (regardless of GSEL [1:0] setting in CNTL1 register. This results in threshold resolution of 3.9 mg/counts. 2^{11} counts/8 g = 2048 counts/8 g = 256 counts/g or 3.9 mg/counts.

4. Threshold Calculation

To calculate the desired Wake-up Threshold (WUFTH) and Back-to-sleep Threshold (BTSTH). Note that the Wake-up engine function is independent of the user selected Acceleration Range. WUFTH (counts) = Wake-up Threshold (g) x 256 (counts/g)

BTSTH (counts) = Back-to-sleep Threshold (g) x 256 (counts/g)

5. Relative/Absolute Threshold Modes Select

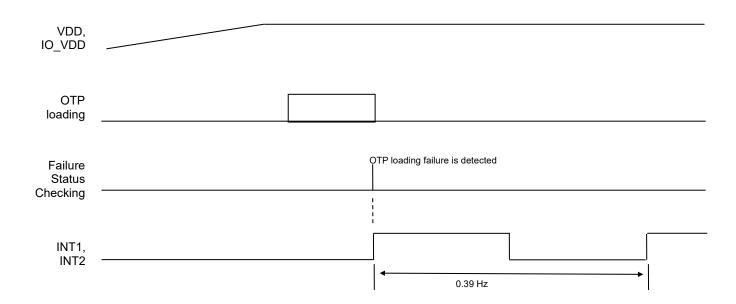
The type of threshold used for motion interrupt is controlled using the TH_MODE bit in BTS_WUF_CNTL register. The threshold can be set to either an absolute acceleration value or a relative acceleration value.

Failure Report Function

KX022ACR-Z has the OTP memory load failure report function which are routed on INT1 and INT2. Note that the failure report function is prioritized than interrupt function. INT1 and INT2 toggle even if the IEN1 and IEN2 are not set, and any interrupt is ignored.

The failures are also reported on the CRC F bit in STATUS REG register.

The CRC_F bit is set, and INT1 and INT2 pins toggle when the failure is detected. Perform Software Reset or Power Cycle the device when the failure is detected. This report function is available with any power-mode.



Sample Buffer Feature Description

The sample buffer feature of the KX022ACR-Z accumulates and outputs acceleration data based on how it is configured. There are 4 buffer modes available, and samples can be accumulated at either low (8-bits) or high (16-bits) resolution. Acceleration data is collected at the ODR specified by OSA [3:0] in the ODCNTL register. Each buffer mode accumulates data, reports data, and interacts with status indicators in a slightly different way.

1. FIFO Mode

Data Accumulation

Sample collection stops when the buffer is full.

Data Reporting

Data is reported with the oldest byte of the oldest sample first (X_L or X, based on resolution).

Status Indicators

A watermark interrupt occurs when the number of samples in the buffer reaches the Sample Threshold. The watermark interrupt stays active until the buffer contains less than this number of samples. This can be accomplished through clearing the buffer or explicitly reading greater than SMPX samples. (calculated with below Equation).

BRES=0:

SMPX = SMP LV [7:0] / 3 - SMP [6:0]

BRES=1:

SMPX = SMP LV [7:0] / 6 - SMP [6:0]

Equation 1. Samples Above Sample Threshold

2. Stream Mode

Data Accumulation

Sample collection continues when the buffer is full; older data is discarded to make room for newer data.

Data Reporting

Data is reported with the oldest sample first (uses FIFO read pointer).

Status Indicators

A watermark interrupt occurs when the number of samples in the buffer reaches the Sample Threshold. The watermark interrupt stays active until the buffer contains less than this number of samples. This can be accomplished through clearing the buffer or explicitly reading greater than SMPX samples (calculated with Equation 1).

3. Triger Mode

Data Accumulation

When a physical interrupt is caused by one of the digital engines, or when a logic HIGH signal occurs on TRIG pin, the trigger event is asserted and SMP_TH [6:0] samples prior to the event are retained. Sample collection continues until the buffer is full

Data Reporting

Data is reported with the oldest sample first (uses FIFO read pointer).

Status Indicators

When a physical interrupt occurs or when a logic HIGH signal occurs on TRIG pin, and there are at least SMP [6:0] samples in the buffer, BUF_TRIG bit in BUF_STATUS_2 is asserted. This bit should be cleared by writing to BUF_CLEAR register to prevent Buffer Full interrupt from firing while TRIG pin remains de-asserted.

4. FILO Mode

Data Accumulation

Sample collection continues when the buffer is full; older data is discarded to make room for newer data.

Data Reporting

Data is reported with the newest byte of the newest sample first (Z_H or Z, based on resolution).

Status Indicators

A watermark interrupt occurs when the number of samples in the buffer reaches the Sample Threshold. The watermark interrupt stays active until the buffer contains less than this number of samples. This can be accomplished through clearing the buffer or explicitly reading greater than SMPX samples (calculated with Equation 1).

Buffer Operation

The following diagrams illustrate the operation of the buffer conceptually. Actual physical implementation has been abstracted to offer a simplified explanation of how the different buffer modes operate. Figure 1 represents a high-resolution 3-axis sample within the buffer. Figure 1 - Figure 10 represent a 10-sample version of the buffer (for simplicity), with Sample Threshold set to 8. Regardless of the selected mode, the buffer fills sequentially, one byte at a time. It is important to keep in mind that new data is not being written to the buffer during the buffer read operation. Thus, care must be taken when reading from the buffer. If data loss is not desired, the buffer read operation should be completed within ODR cycle.

Figure 1 shows one 6-bytes data sample. Note the location of the FILO read pointer versus that of the FIFO read pointer.

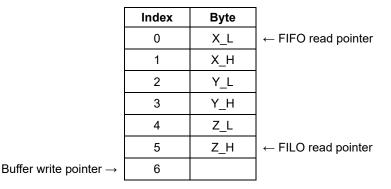


Figure 1. One Buffer Sample

Regardless of the selected mode, the buffer fills sequentially, one sample at a time. Note in Figure 2 the location of the FILO read pointer versus that of the FIFO read pointer. The buffer write pointer shows where the next sample will be written to the buffer

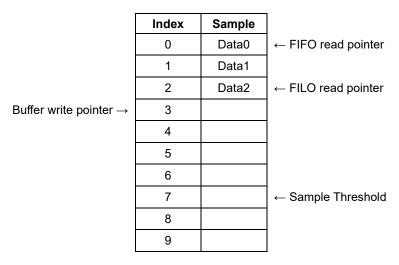


Figure 2. Buffer Filling

The buffer continues to fill sequentially until the Sample Threshold is reached. Note in Figure 3 the location of the FILO read pointer versus that of the FIFO read pointer.

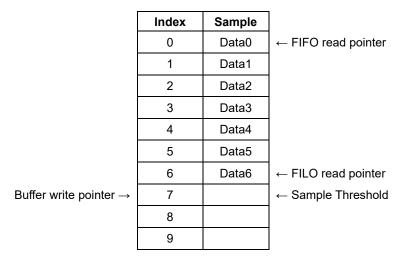


Figure 3. Buffer Approaching Sample Threshold

In FIFO, Stream, and FILO modes, a watermark interrupt is issued when the number of samples in the buffer reaches the Sample Threshold. In trigger mode, this is the point where the oldest data in the buffer is discarded to make room for newer data.

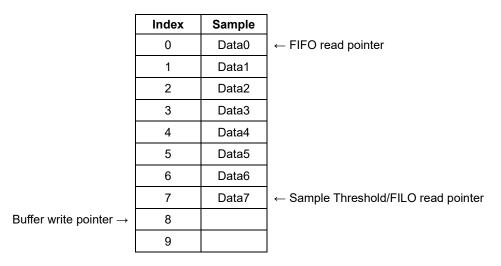


Figure 4. Buffer at Sample Threshold

In trigger mode, data is accumulated in the buffer sequentially until the Sample Threshold is reached. Once the Sample Threshold is reached, the oldest samples are discarded when new samples are collected. Note in Figure 5 how Data0 was thrown out to make room for Data8.

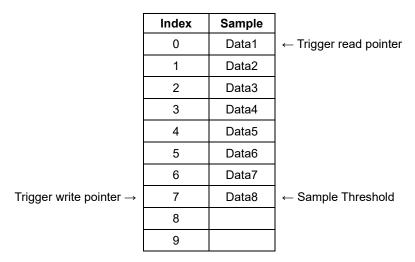


Figure 5. Additional Data Prior to Trigger Event

After a trigger event occurs, the buffer no longer discards the oldest samples, and instead begins accumulating samples sequentially until full. The buffer then stops collecting samples, as seen in Figure 6. This results in the buffer holding SMP [6:0] samples prior to the trigger event, and SMPX samples after the trigger event.

| Index | Sample | |
|--------|--------|------------------------|
| IIIUEX | Gample | |
| 0 | Data1 | ← Trigger read pointer |
| 1 | Data2 | |
| 2 | Data3 | |
| 3 | Data4 | |
| 4 | Data5 | |
| 5 | Data6 | |
| 6 | Data7 | |
| 7 | Data8 | ← Sample Threshold |
| 8 | Data9 | |
| 9 | Data10 | |
| | | |

Figure 6. Additional Data After Trigger Event

In FIFO, Stream, FILO, and Trigger (after a trigger event has occurred) modes, the buffer continues filling sequentially after the Sample Threshold is reached. Sample accumulation after the buffer is full depends on the selected operation mode. FIFO and Trigger modes stop accumulating samples when the buffer is full, and Stream and FILO modes begin discarding the oldest data when new samples are accumulated.

| Index | Sample | |
|-------|--------|---------------------|
| 0 | Data0 | ← FIFO read pointer |
| 1 | Data1 | |
| 2 | Data2 | |
| 3 | Data3 | |
| 4 | Data4 | |
| 5 | Data5 | |
| 6 | Data6 | |
| 7 | Data7 | ← Sample Threshold |
| 8 | Data8 | |
| 9 | Data9 | ← FILO read pointer |

Figure 7. Buffer Full

After the buffer has been filled in FILO or Stream mode, the oldest samples are discarded when new samples are collected. Note in Figure 8 how Data0 was thrown out to make room for Data10.

| Index | Sample | |
|-------|--------|---------------------|
| 0 | Data1 | ← FIFO read pointer |
| 1 | Data2 | |
| 2 | Data3 | |
| 3 | Data4 | |
| 4 | Data5 | |
| 5 | Data6 | |
| 6 | Data7 | |
| 7 | Data8 | ← Sample Threshold |
| 8 | Data9 | |
| 9 | Data10 | ← FILO read pointer |

Figure 8. Buffer Full - Additional Sample Accumulation in Stream or FILO Mode

In FIFO, Stream, or Trigger mode, reading one sample from the buffer will remove the oldest sample and effectively shift the entire buffer contents up, as seen in Figure 9.

| | Index | Sample | |
|------------------------------------|-------|--------|---------------------|
| | 0 | Data1 | ← FIFO read pointer |
| | 1 | Data2 | |
| | 2 | Data3 | |
| | 3 | Data4 | |
| | 4 | Data5 | |
| | 5 | Data6 | |
| | 6 | Data7 | |
| | 7 | Data8 | ← Sample Threshold |
| | 8 | Data9 | ← FILO read pointer |
| Buffer write pointer \rightarrow | 9 | | |

Figure 9. FIFO Read from Full Buffer

In FILO mode, reading one sample from the buffer will remove the newest sample and leave the older samples untouched, as seen in Figure 10.

| | | | 1 |
|------------------------|-------|--------|---------------------|
| | Index | Sample | |
| | 0 | Data0 | ← FIFO read pointer |
| | 1 | Data1 | |
| | 2 | Data2 | |
| | 3 | Data3 | |
| | 4 | Data4 | |
| | 5 | Data5 | |
| | 6 | Data6 | |
| | 7 | Data7 | ← Sample Threshold |
| | 8 | Data8 | ← FILO read pointer |
| Buffer write pointer → | 9 | | |
| | • | | - |

Figure 10. FILO Read from Full Buffer

Typical Performance Curves

(Reference data) (Unless otherwise specified V_{VDD} = 2.5 V Ta = 25 °C)

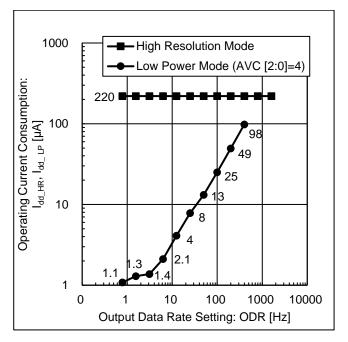


Figure 11. Operating Current Consumption vs ODR

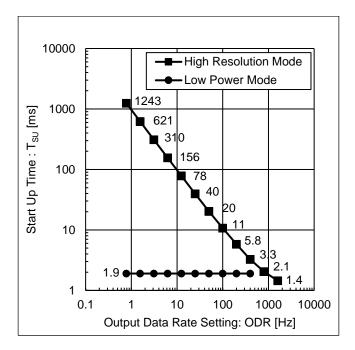
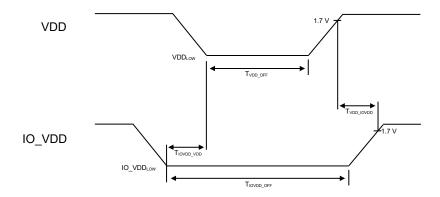


Figure 12. Start Up Time vs ODR

Power On Procedure

Proper functioning of power-on reset (POR) is dependent on the specific VDD_{LOW} and T_{VDD_OFF} profile of individual applications. It is recommended to minimize VDD_{LOW} and maximize T_{VDD_OFF}. It is also advised that the VDD ramp up time be monotonic. To assure proper POR, the application should be evaluated over the customer specified range of VDD, VDD_{LOW}, T_{VDD_OFF} and temperature as POR performance can vary depending on these parameters. Bench Testing has demonstrated POR performance regions for a proper POR trigger. To assure POR trigger properly executes, setting operational thresholds consistent with Table as follows.



| Parameters | Units | Min | Тур | Max |
|--|-------|-----|-----|-----|
| VDD off time: T _{VDD_OFF} | ms | 10 | - | - |
| IO_VDD off time: Tiovdd_off | ms | 10 | - | - |
| VDD low voltage: VDD _{LOW} | mV | - | - | 250 |
| IO_VDD low voltage: IO_VDDLOW | mV | - | - | 250 |
| IO_VDD low to VDD low time: T _{IOVDD_VDD} | ms | 0 | - | - |
| VDD high to IO_VDD high time: Tvdd_lovdd | ms | 0 | - | - |

(Note) VDD and IO_VDD must always be monotonic ramps without ambiguous state.

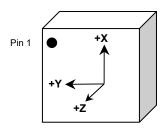
The V_{IO_VDD} must remain $\leq V_{VDD}$.

In order to prevent entering an ambiguous state, both VDD and IO_VDD need to be pulled down to GND (≤ 250 mV) for duration of time ≥ 10 ms. The Power-up time is specified in the Electrical Characteristics table

It is important the user determines the timing (T_{VDD_OFF}) and threshold (VDD_{LOW}) levels by evaluating the performance in the specific system for which the device will be incorporated.

Orientation

When device is accelerated in +X, +Y or +Z direction, the corresponding output will increase.



Static X/Y/Z Output Response versus Orientation to Earth's surface (1 g):

GSEL [1:0] = 0 (±2 g)

| Position | 1 | | 2 | | 3 | | 4 | | 5 | | 6 | |
|-------------------|--------|-----|--------|-----|--------|-----|--------|---------------|--------|---------------|--------|-----|
| Diagram | | | | | | | | Top Bottom | | Bottom Top | | |
| Resolution (bits) | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 |
| X (counts) | +16384 | +64 | 0 | 0 | -16384 | -64 | 0 | 0 | 0 | 0 | 0 | 0 |
| Y (counts) | 0 | 0 | -16384 | -64 | 0 | 0 | +16384 | +64 | 0 | 0 | 0 | 0 |
| Z (counts) | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | +16384 | +64 | -16384 | -64 |
| | | | | | | | | | | | | |
| X-Polarity | + | | 0 | | - | | 0 | | 0 | | 0 | |
| Y-Polarity | 0 | | - | | 0 | | + | | 0 | | 0 | |
| Z-Polarity | 0 | | 0 | | 0 | | 0 | | + | | - | |

(1 g)

Earth's Surface

Static X/Y/Z Output Response versus Orientation to Earth's surface (1 g):

GSEL [1:0] = 1 (±4 g)

| Position | 1 | | 2 | | 3 | | 4 | | 5 | | 6 | |
|-------------------|-------|-----|-------|-----|-------|-----|-------|-----|---------------|-----|------------|-----|
| Diagram | | | | | | | | | Top Bottom | | Bottom Top | |
| Resolution (bits) | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 |
| X (counts) | +8192 | +32 | 0 | 0 | -8192 | -32 | 0 | 0 | 0 | 0 | 0 | 0 |
| Y (counts) | 0 | 0 | -8192 | -32 | 0 | 0 | +8192 | +32 | 0 | 0 | 0 | 0 |
| Z (counts) | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | +8192 | +32 | -8192 | -32 |
| | | | | | | | | | | | | |
| X-Polarity | + | | 0 | | - | | 0 | | 0 | | 0 | |
| Y-Polarity | 0 | | - | | 0 | | + | | 0 | | 0 | |
| Z-Polarity | 0 | | 0 | | 0 | | 0 | | + | | - | |

(1 g)

Earth's Surface

Orientation - continued

Static X/Y/Z Output Response versus Orientation to Earth's surface (1 g): $\mathsf{GSEL}\ [1:0] = 2\ (\pm 8\ \mathsf{g})$

| 1 | | 2 | | 3 | | 4 | | 5 | | 6 | | | | | | | | | |
|-------|----------------------|-----------------------------------|--|--|---|--|---|---|--|--|---|--|--|--|-----|--|--|---------------|--|
| | | | | | | | | | | | | | | | Top | | | Bottom Top | |
| 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | | | | | | | | |
| +4096 | +16 | 0 | 0 | -4096 | -16 | 0 | 0 | 0 | 0 | 0 | 0 | | | | | | | | |
| 0 | 0 | -4096 | -16 | 0 | 0 | +4096 | +16 | 0 | 0 | 0 | 0 | | | | | | | | |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | +4096 | +16 | -4096 | -16 | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | |
| + | | 0 | | - | | 0 | | 0 | | 0 | | | | | | | | | |
| 0 | | - | | 0 | | + | | 0 | | 0 | | | | | | | | | |
| 0 | | 0 | | 0 | | 0 | | + | | - | | | | | | | | | |
| | +4096 0 0 + | +4096 +16 0 0 0 0 + 0 | 16 8 16 +4096 +16 0 0 0 -4096 0 0 0 | 16 8 16 8 +4096 +16 0 0 0 0 -4096 -16 0 0 0 0 | 16 8 16 8 16 +4096 +16 0 0 -4096 0 0 -4096 -16 0 0 0 0 0 0 0 | 16 8 16 8 16 8 +4096 +16 0 0 -4096 -16 0 0 -4096 -16 0 0 0 0 0 0 0 0 + 0 - 0 - 0 - 0 0 | 16 8 16 8 16 8 16 +4096 +16 0 0 -4096 -16 0 0 0 -4096 -16 0 0 +4096 0 0 0 0 0 0 + 0 - 0 0 0 - 0 + | 16 8 16 8 16 8 16 8 +4096 +16 0 0 -4096 -16 0 0 0 0 -4096 -16 0 0 +4096 +16 0 0 0 0 0 0 0 0 + 0 - 0 - 0 + 0 - 0 + 0 - 0 | Top Bottom 16 8 16 8 16 8 16 8 16 +4096 +16 0 0 -4096 -16 0 0 0 0 0 -4096 -16 0 0 +4096 +16 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 + 0 0 0 0 | 16 8 16 8 16 8 16 8 16 8 +4096 +16 0 0 -4096 -16 0 0 0 0 0 0 0 -4096 -16 0 0 +4096 +16 0 | 16 8 16 9 0 | | | | | | | | |

↓ (1 g)

Earth's Surface

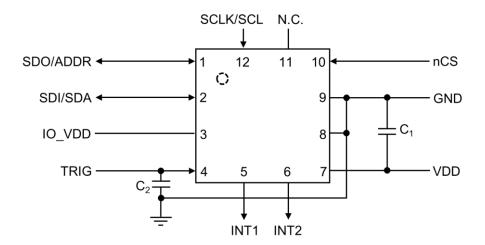
Static X/Y/Z Output Response versus Orientation to Earth's surface (1 g): $\mathsf{GSEL}\ [1:0] = 3\ (\pm 16\ g)$

| Position | 1 | | 2 | | 3 | | 4 | | 5 | | 6 | | |
|-------------------|-------|----|-------|----|-------|----|-------|----|-------|---------------|-------|------------|--|
| Diagram | | | | | | | | | | Top Bottom | | Bottom Top | |
| Resolution (bits) | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | 16 | 8 | |
| X (counts) | +2048 | +8 | 0 | 0 | -2048 | -8 | 0 | 0 | 0 | 0 | 0 | 0 | |
| Y (counts) | 0 | 0 | -2048 | -8 | 0 | 0 | +2048 | +8 | 0 | 0 | 0 | 0 | |
| Z (counts) | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | +2048 | +8 | -2048 | -8 | |
| | | | | | | | | | | | | | |
| X-Polarity | + | | 0 | | _ | | 0 | | 0 | | 0 | | |
| Y-Polarity | 0 | | - | | 0 | | + | | 0 | | 0 | | |
| Z-Polarity | 0 | | 0 | | 0 | | 0 | | + | | - | | |

(1 g)

Earth's Surface

Application Example



I/O Equivalence Circuits

| Equivalence Circuits | | | |
|-------------------------|---------------------|---------------------|---------------------|
| Pin Name | Equivalence Circuit | Pin Name | Equivalence Circuit |
| VDD IO_VDD | □ → → | SDI/SDA SDO/ADDR | IO_VDD |
| SCLK/SCL TRIG nCS | IO_VDD | INT1 INT2 | IO_VDD VDD |

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Recommended Operating Conditions

The function and operation of the IC are guaranteed within the range specified by the recommended operating conditions. The characteristic values are guaranteed only under the conditions of each item specified by the electrical characteristics.

6. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

7. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

8. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

9. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

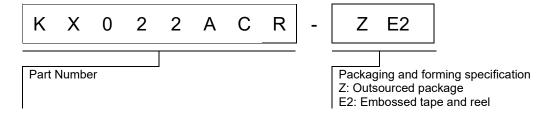
10. Regarding the Input Pin of the IC

In the construction of this IC, P-N junctions are inevitably formed creating parasitic diodes or transistors. The operation of these parasitic elements can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions which cause these parasitic elements to operate, such as applying a voltage to an input pin lower than the ground voltage should be avoided. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. Even if the power supply voltage is applied, make sure that the input pins have voltages within the values specified in the electrical characteristics of this IC.

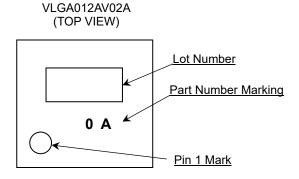
11. Ceramic Capacitor

When using a ceramic capacitor, determine a capacitance value considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

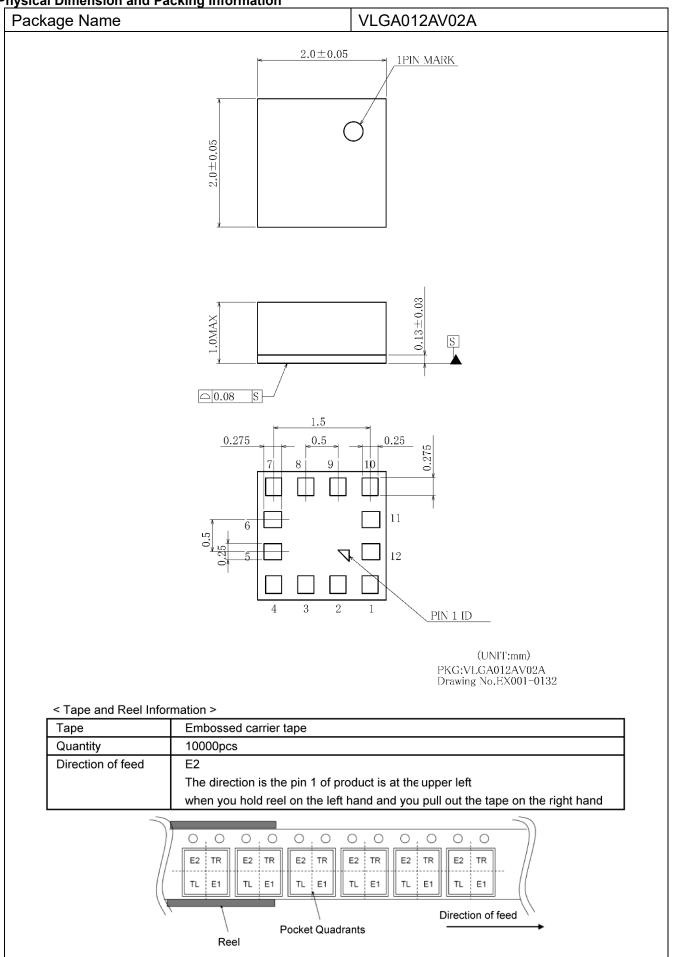
Ordering Information



Marking Diagram



Physical Dimension and Packing Information



Revision History

| Date | Revision | Changes |
|-------------|----------|-------------|
| 16.Jun.2023 | 001 | New Release |

Notice

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| JÁPAN | USA | EU | CHINA |
|---------|---------|------------|----------|
| CLASSⅢ | CLASSII | CLASS II b | CLASSIII |
| CLASSIV | | CLASSⅢ | |

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 - [h] Use of the Products in places subject to dew condensation
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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